

COMPUTATIONAL METAMATERIAL DESIGN

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OUTLINE

- Computational metamaterial design
- Microscale analysis
- Multiscale problem as a macroscopic one with inhomogeneous material
- Macroscopic thermo-mechanical response as a function of microstructure
- Material design as an optimization problem
- Applications:
 - Optimization of the mechanical response under thermal loads
 - Optimization of the thermal response using free material optimization (FMO)
 - Heat flux manipulation
 - Design of easy-to-make devices using discrete material optimization (DMO)
 - Design of easiest-to-make devices using topology optimization
- Advantages of computational metamaterial design
- Perspectives

METAMATERIAL DESIGN

- **MATERIAL DESIGN:** to modify the microstructure of the material in a macroscopic piece in order to obtain an optimal response of the piece
- **METAMATERIAL:** the so-designed material, usually having extraordinary **effective** properties:
 - optical or acoustical camouflage /invisibility
 - negative Poisson ratio
 - negative thermal conductivity, thermal camouflage, etc.

COMPUTATIONAL METAMATERIAL DESIGN

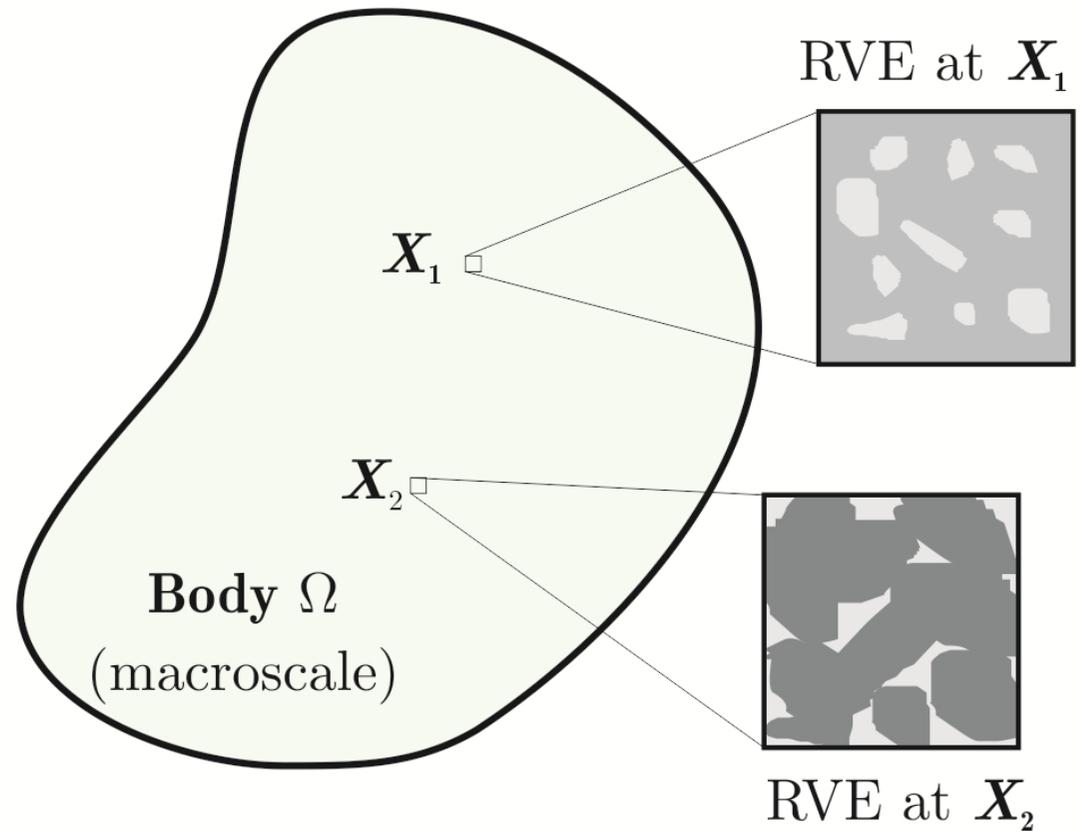
- **Computational Metamaterial Design (CMMD)** involves the computational solution of a series of multiscale problems for changing microstructure



until finding the optimal macroscopic response

MACROSCOPIC BODY WITH VARIABLE MICROSTRUCTURE

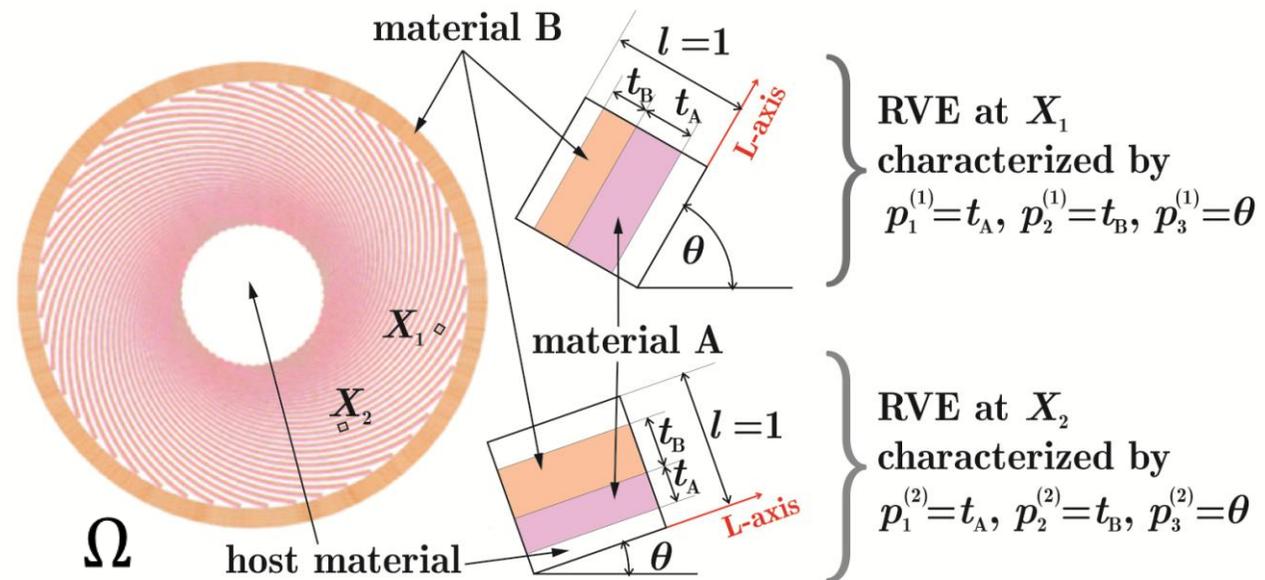
- Let the microstructure vary throughout the macroscopic domain, being sampled at a series of points \mathbf{X}_α
- Each \mathbf{X}_α has its own Representative Volume Element (RVE)



QUANTITATIVELY CHARACTERIZED MICROSTRUCTURE

- Let the RVE at any sampling point $X_\alpha \in \Omega$ be characterized by a finite number of (micro)parameters $p_1^{(\alpha)}, p_2^{(\alpha)}, \dots$

Ex.: Narayana & Sato's heat flux inverter (PRL 2012)

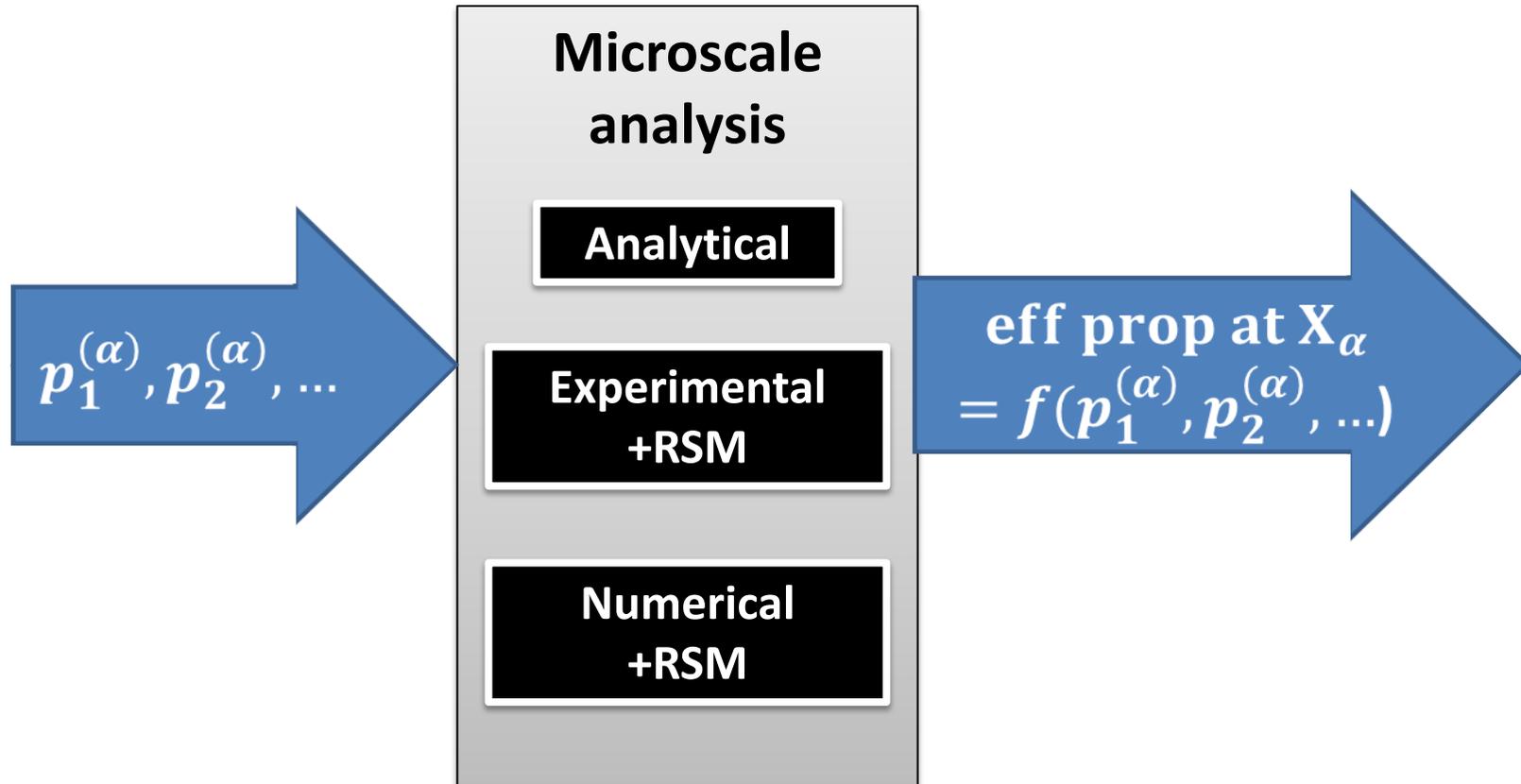


\Rightarrow Effective properties at $X_\alpha \in \Omega = f(p_1^{(\alpha)}, p_2^{(\alpha)}, \dots)$

MICROSCALE ANALYSIS

MICROSCALE ANALYSIS

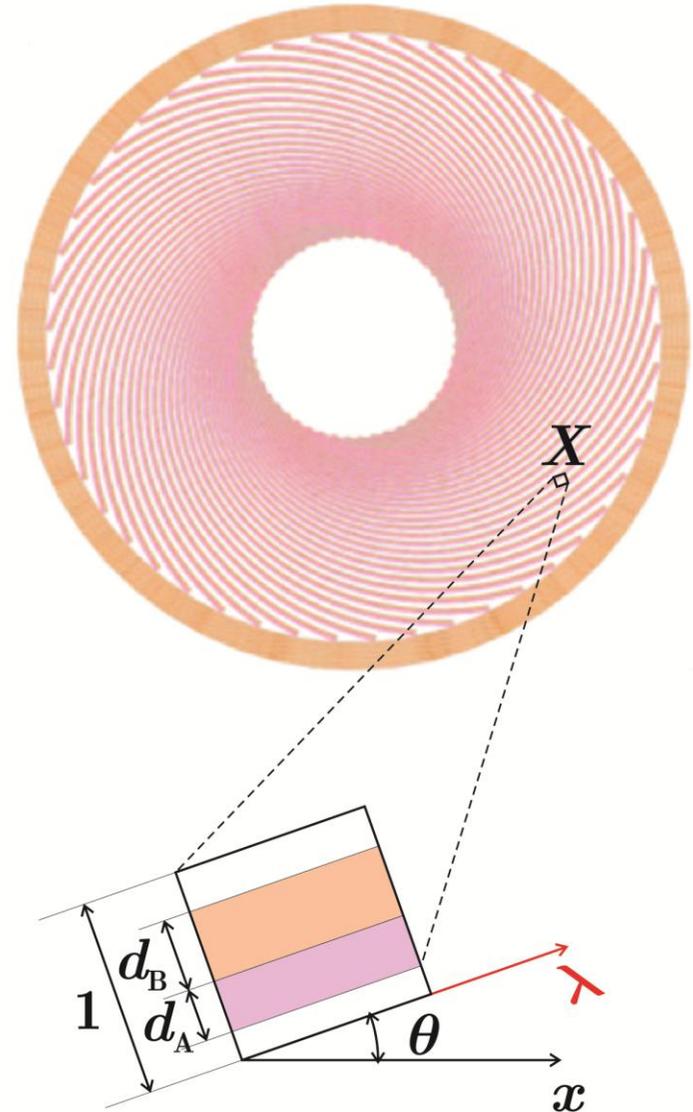
- **Goal:** determination of the effective properties as analytical functions of the microparameters



ANALYTICAL MICROSCALE ANALYSIS: LAMINATE

- Effective anisotropic conductivity

$$k_{eff} = \frac{d_A k_A + d_B k_B + d_C k_C}{d_A + d_B + d_C}$$



EXPERIMENTAL+NUMERICAL MICROSCALE ANALYSIS: PAPER

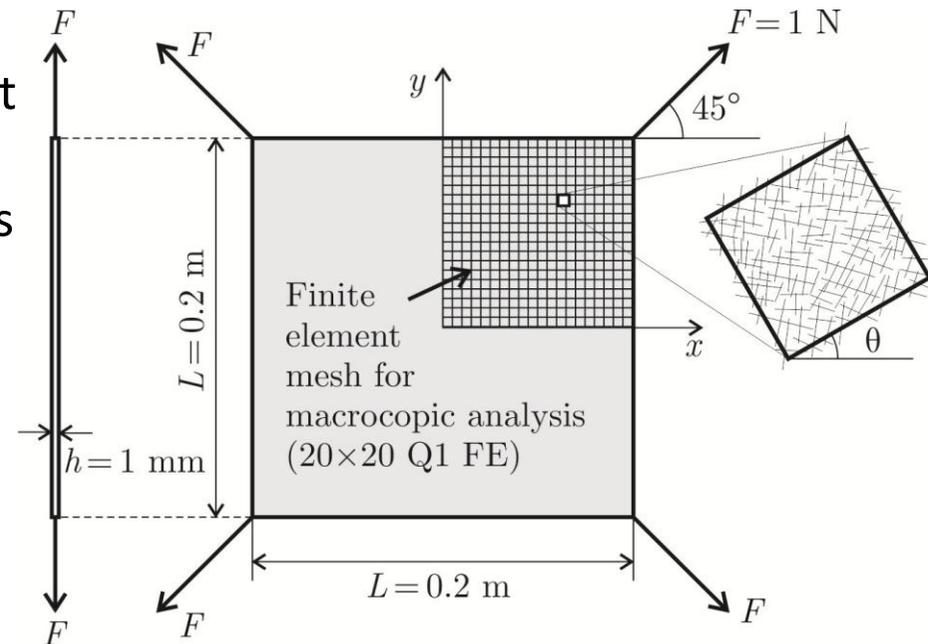
- Using upscaling techniques, discrete element simulations and X-ray microtomography of the geometry of wood fibers and their bonds and the architecture of the fibrous network, **Marulier** (PhD thesis 2013) determined the **homogenized elastic moduli**:

$$\mathbf{C}^{\text{orth}} = 1.14 \times 10^9 (\phi - 0,02)^2 \mathbf{A}(a)$$

$$\Rightarrow \mathbf{C}_{xy} = \mathbf{\Theta}(\theta) \mathbf{C}^{\text{orth}}(\phi, a) [\mathbf{\Theta}(\theta)]^T$$

- ϕ : fiber content
- $\mathbf{A}(a)$: fiber orientation tensor (response surface from experiments), a : orientation intensity
- $\mathbf{\Theta}(\theta)$: serves to rotate from $\lambda\tau$ to xy , θ : angle between the x and λ

* Collaboration with S. Le Corre (LTN Nantes) and L. Org as (LCNRS Grenoble)



NUMERICAL MICROSCALE ANALYSIS: CANCELLOUS BONE

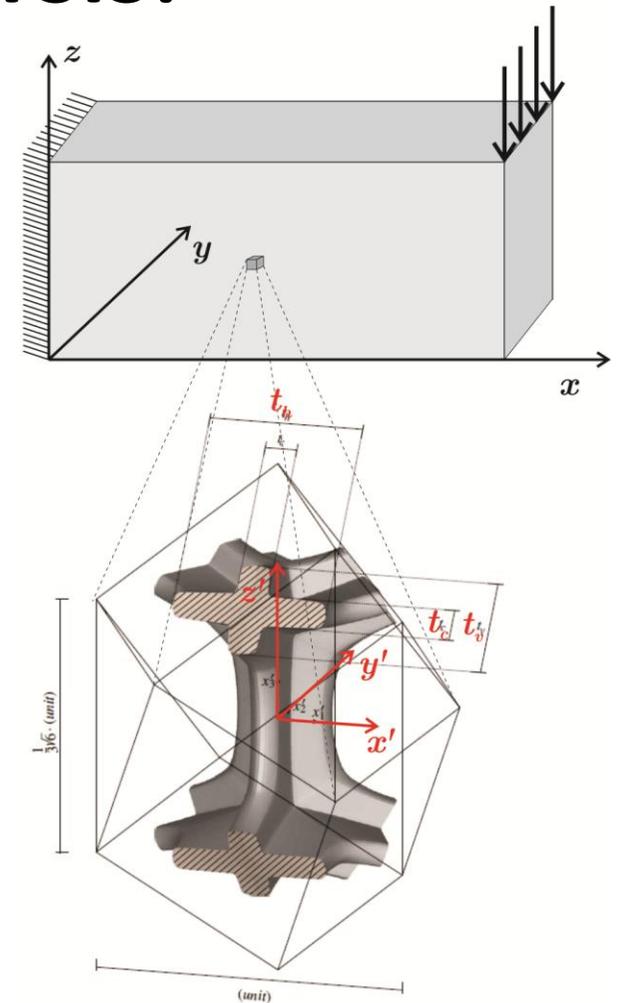
- Using FEM for a geometrically parameterized cell, Kowalczyk (2006) determined the **homogenized elastic moduli**:

$$C'_{ijkl} = f(t_c, t_v, t_h)$$

$$\Rightarrow C_{ijkl} = R_{mi}R_{nj}R_{pk}R_{ql}C'_{mnpq}$$

- t_c, t_v, t_h : geometric parameters
- $R(\psi_1, \psi_2, \psi_3)$: 3D rotation tensor

* Collaboration with A. Cisilino & L. Colabella (INTEMA)



NUMERICAL MICROSCALE ANALYSIS: SOLID WITH INCLUSIONS

- Using FEM on RVEs with variable b and h , we determined the effective thermomechanical properties

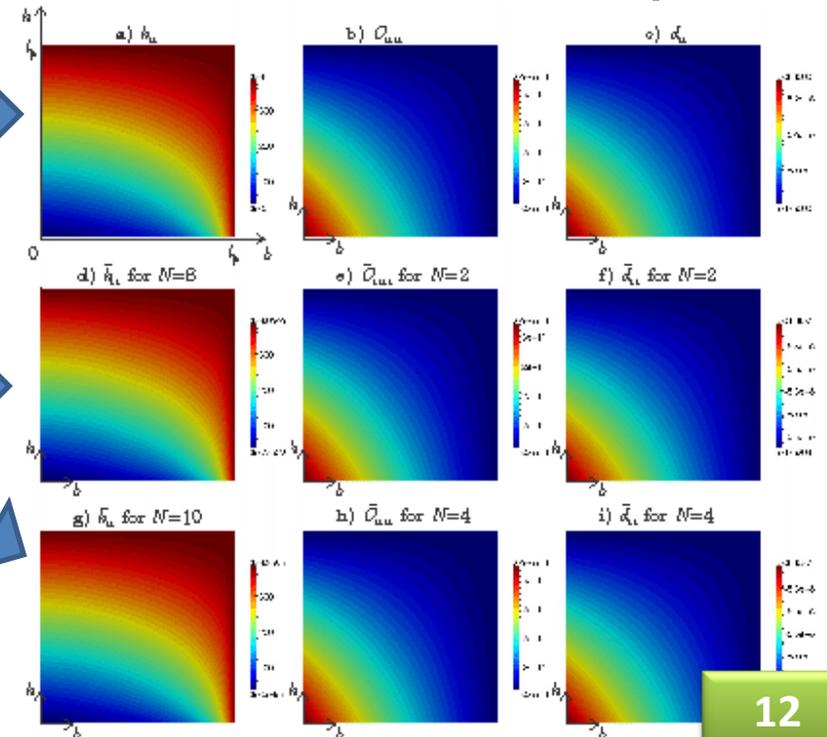
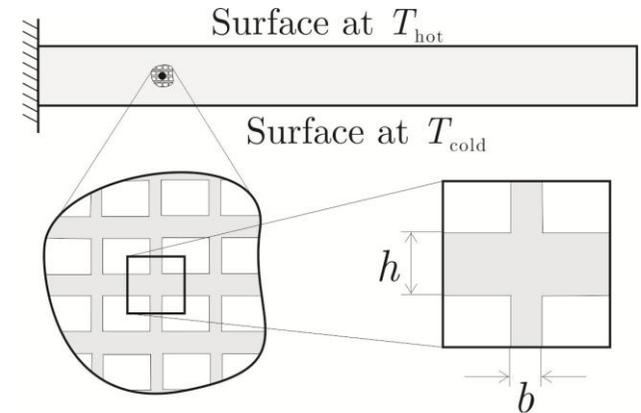
$$k_{ij} = k_{ij}(b, h)$$

$$C_{ijkl} = C_{ijkl}(b, h)$$

$$\frac{\partial \sigma_{ij}}{\partial T} = d_{ij}(b, h)$$

GRIDS FROM FEM
PARAMETRIC
ANALYSIS

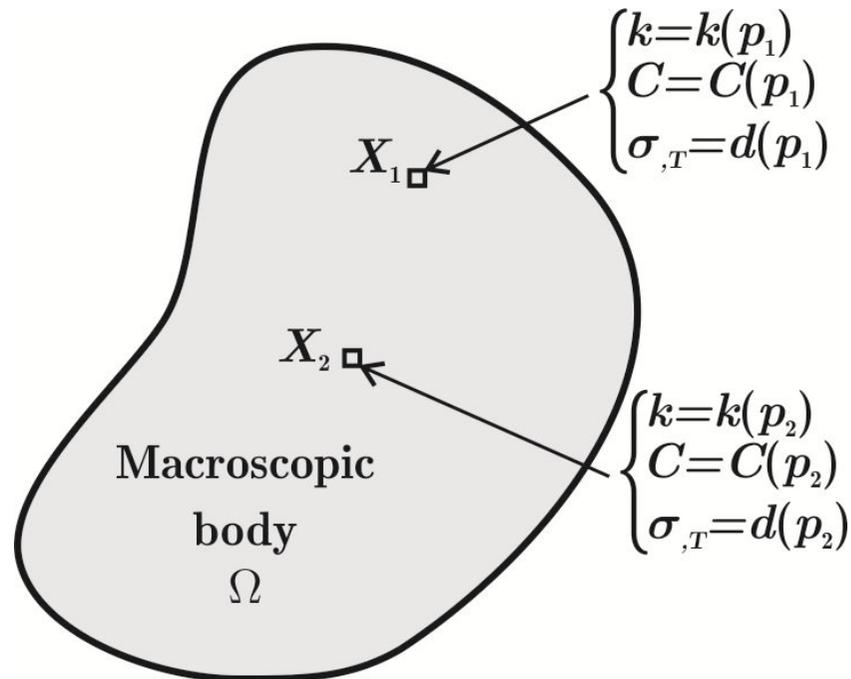
POLYNOMIAL
RESPONSE
SURFACES



* Fachinotti, Toro, Sánchez & Huespe,
IJSS 2015

REDUCTION OF THE MULTISCALE PROBLEM

- Once you know the effective material properties as functions of the microparameters \mathbf{p} from the microscale analysis, the multiscale problem becomes a **classic macroscopic problem with inhomogeneous material properties**



MACROSCOPIC THERMO-MECHANICAL RESPONSE AS A FUNCTION OF MICROSTRUCTURE

THERMOMECHANICAL RESPONSE AS A FUNCTION OF MICROSTRUCTURE

- Given the microstructure $\mathbf{P} = [\mathbf{p}_1, \mathbf{p}_2, \dots]$ throughout Ω :

1) solve the steady state FEM heat equation:

$$\int_{\Omega} \mathbf{B}^T \mathbf{k}(\mathbf{p}) \mathbf{B} dv \mathbf{T} + \int_{\partial\Omega_q} \mathbf{N}^T q^{\text{wall}} ds = \mathbf{0}$$
$$\Rightarrow \mathbf{T} = \mathbf{T}(\mathbf{P})$$

2) solve the FEM equilibrium equation:

$$\int_{\Omega} \mathbf{B}^T \mathbf{C}(\mathbf{p}) \mathbf{B} dv \mathbf{U} + \int_{\partial\Omega_{\sigma}} \mathbf{N}^T \mathbf{t}^{\text{wall}} ds - \int_{\Omega} \mathbf{B}^T \boldsymbol{\sigma}_{, T}(\mathbf{p}) \Delta T(\mathbf{P}) dv = \mathbf{0}$$
$$\Rightarrow \mathbf{U} = \mathbf{U}(\mathbf{P})$$

- The macroscopic thermo-mechanical response is the function

$$\mathcal{R} = f(\mathbf{U}(\mathbf{P}), \mathbf{T}(\mathbf{P}), \mathbf{P}) = \mathcal{R}(\mathbf{P})$$

MATERIAL DESIGN AS AN OPTIMIZATION PROBLEM

- To design a material consists of finding the optimal set

$$\mathbf{P}^{\text{opt}} = \left\{ p_1^{(1)}, p_2^{(1)}, \dots, p_1^{(2)}, p_2^{(2)}, \dots \right\}^{\text{opt}}$$

that minimizes a given response function (describing the desired macroscopic task)

$$\mathcal{R}(\mathbf{P}^{\text{opt}}) = \min_{\mathbf{P}} \mathcal{R}(\mathbf{P})$$

subject to

$$a \leq P_i \leq b, c(\mathbf{P}) \leq 0, d(\mathbf{P}) = 0$$

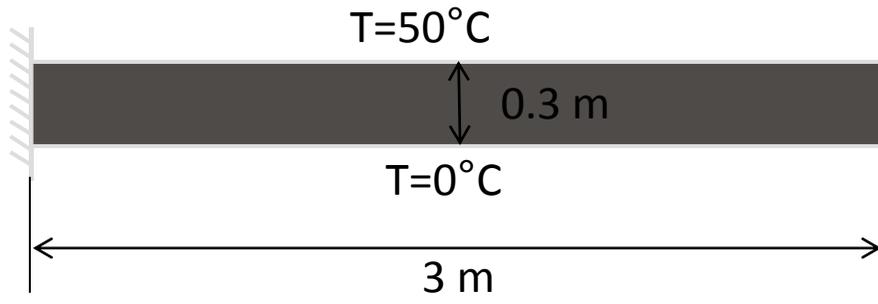
- This is generally a nonlinear constrained optimization problem with a large number of design variables

MATERIAL DESIGN FOR OPTIMAL MACROSCOPIC MECHANICAL RESPONSE UNDER THERMAL LOADS

with

S. Toro, P. Sánchez & A. Huespe (CIMEC)

THERMAL DEFLECTION OF A CANTILEVER PLATE



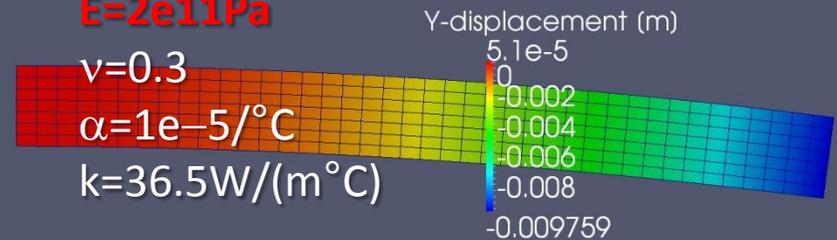
STEEL

$E=2e11\text{Pa}$

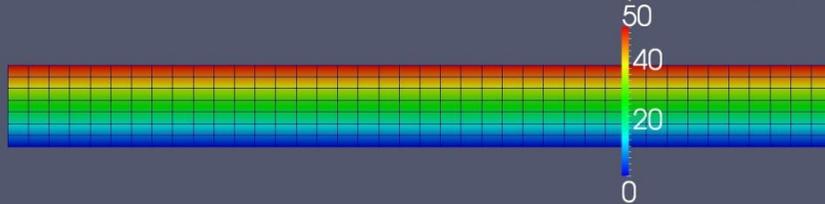
$\nu=0.3$

$\alpha=1e-5/^{\circ}\text{C}$

$k=36.5\text{W}/(\text{m}^{\circ}\text{C})$



Temperature ($^{\circ}\text{C}$)



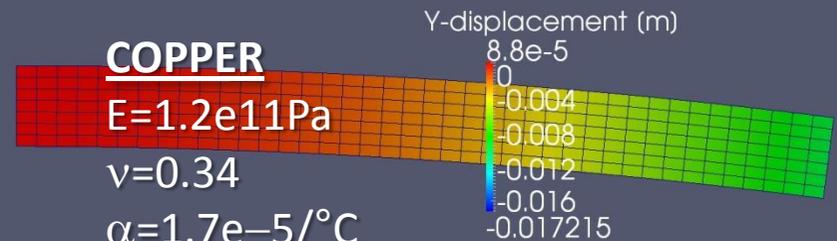
COPPER

$E=1.2e11\text{Pa}$

$\nu=0.34$

$\alpha=1.7e-5/^{\circ}\text{C}$

$k=384\text{W}/(\text{m}^{\circ}\text{C})$

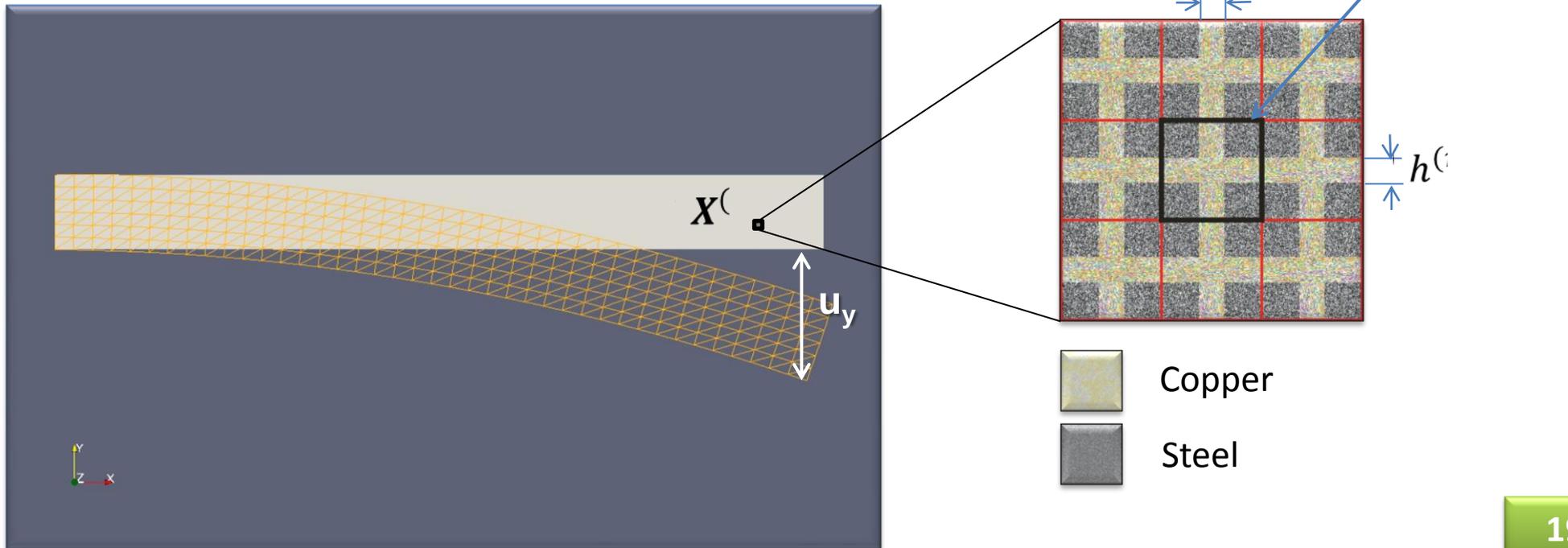


OPTIMIZING THE COMPLIANCE/STIFFNESS

- The maximal/minimal compliance problem consists of finding

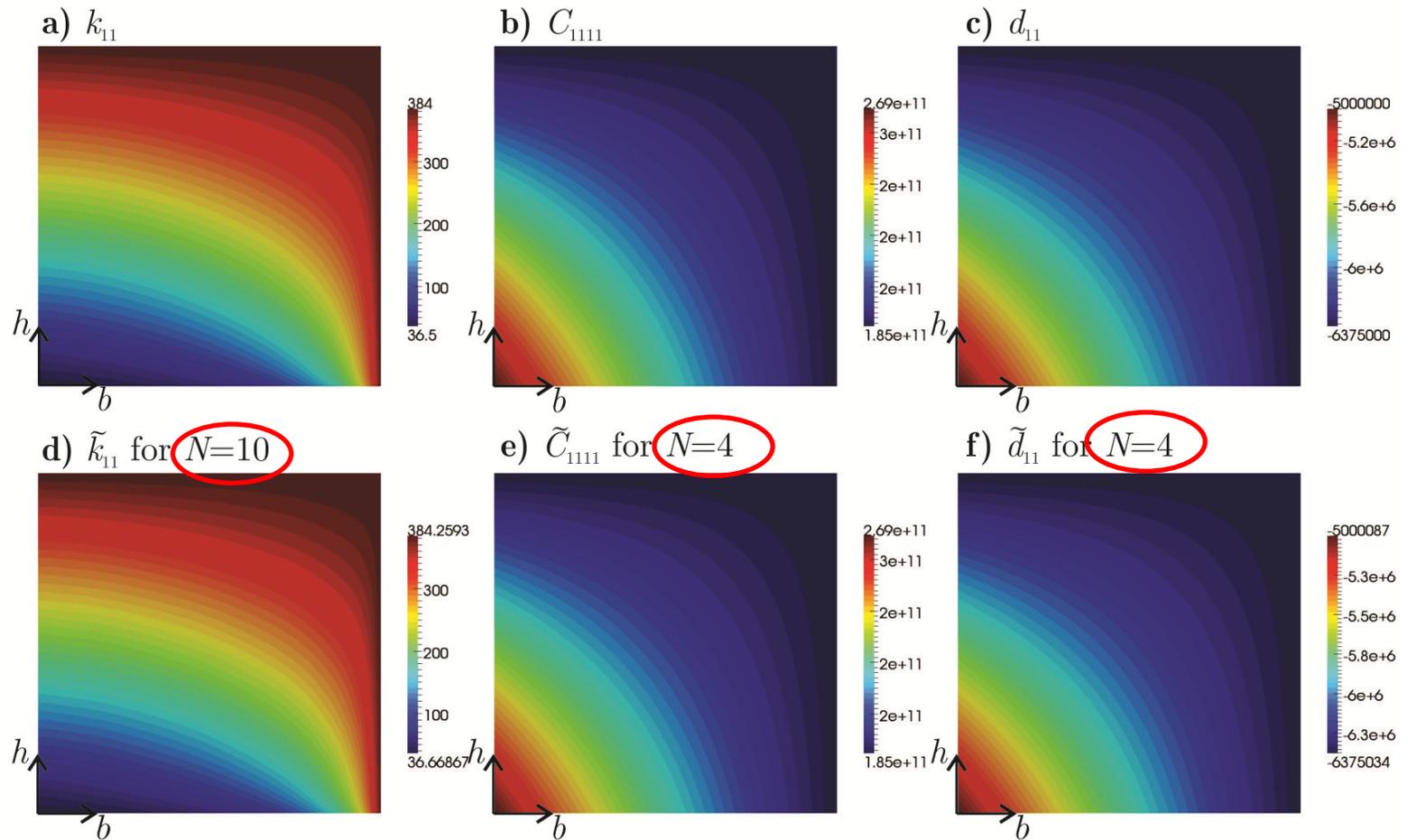
$$\mathbf{P}^{\text{opt}} = [b^{(1)}, h^{(1)}, b^{(2)}, h^{(2)}, \dots]^{\text{opt}} \text{ such that}$$

$$u_y(\mathbf{P}^{\text{opt}}) = \max_{\mathbf{P}} / \min_{\mathbf{P}}(u_y)$$



EFFECTIVE PROPERTIES AS FUNCTIONS OF MICROSTRUCTURE

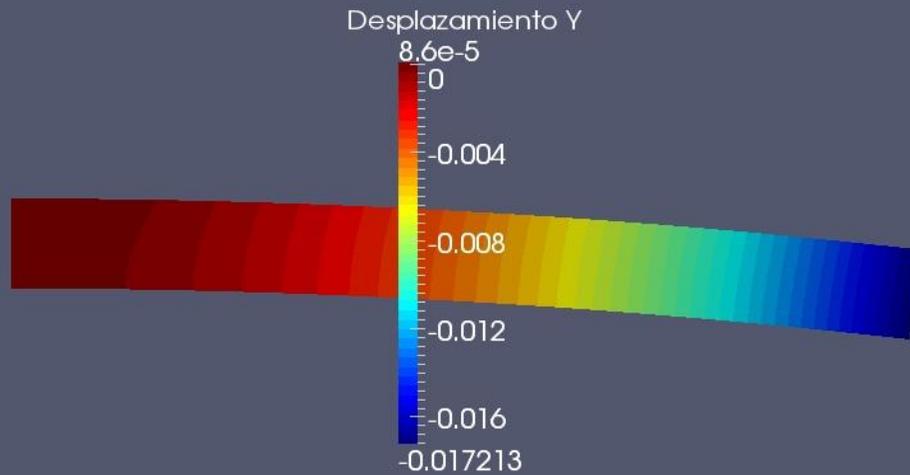
Grids from FEM microscale analysis



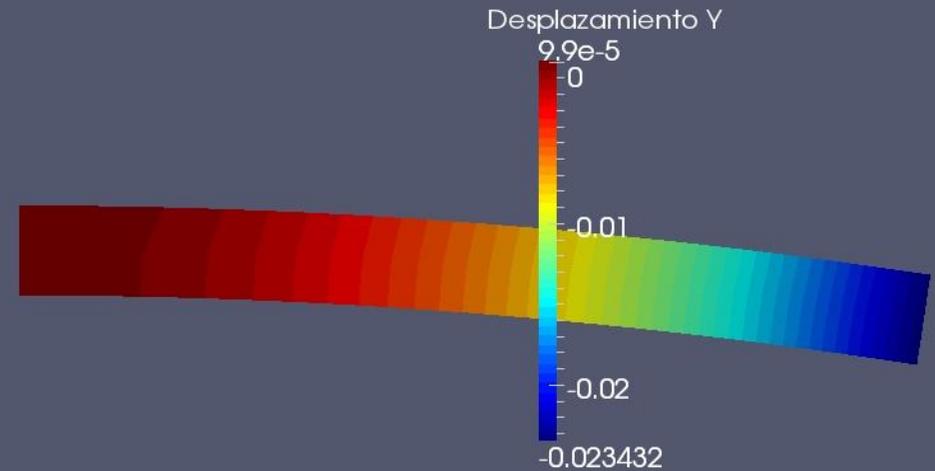
Polynomial response surfaces

MAXIMAL COMPLIANCE: VERTICAL DISPLACEMENTS

Copper beam



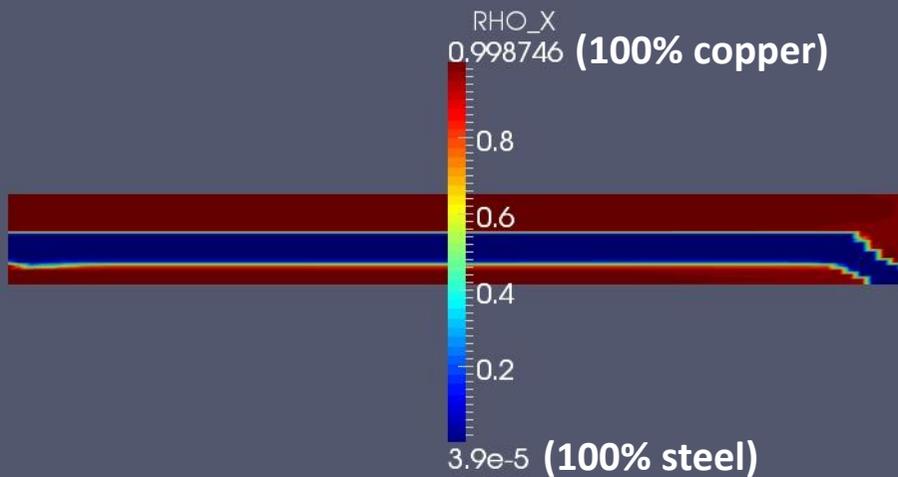
Optimal beam



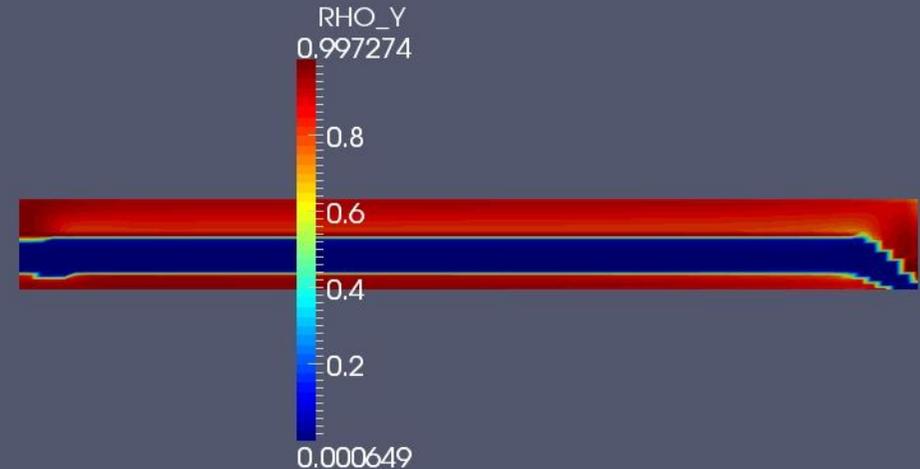
$$u_y = 1.361 u_{y,copper}$$

MAXIMAL COMPLIANCE: OPTIMAL MATERIAL DISTRIBUTION

Thickness of the vertical layers

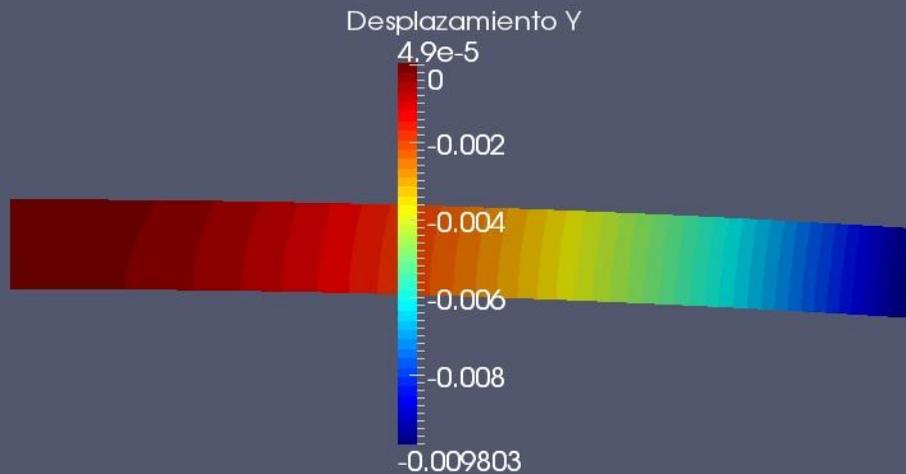


Thickness of the horizontal layers

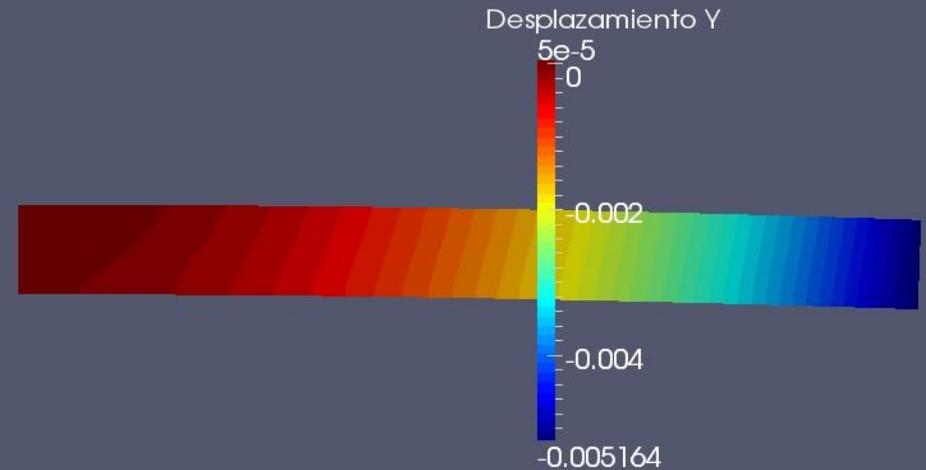


MINIMAL COMPLIANCE: VERTICAL DISPLACEMENTS

Steel beam



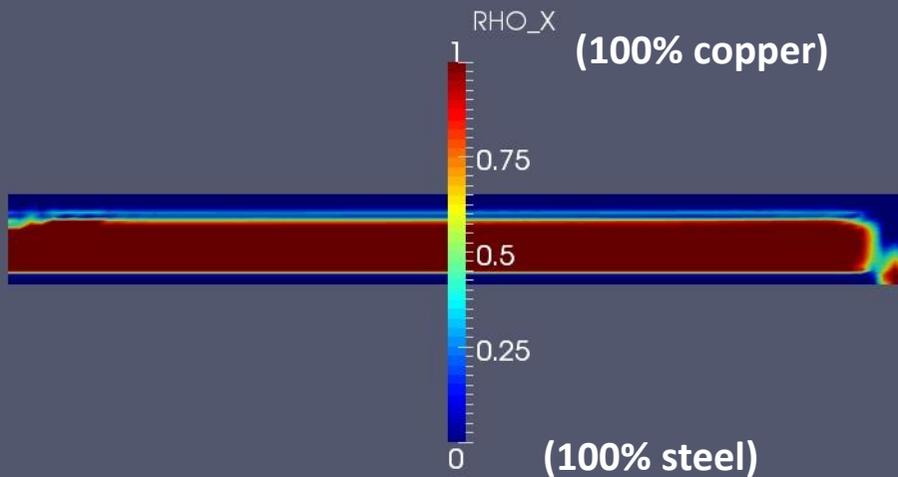
Optimal beam



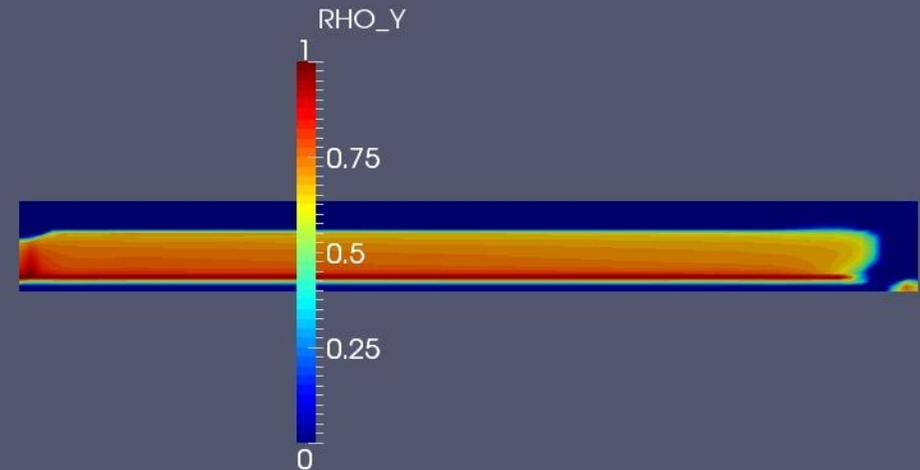
$$u_y = 0.527 u_{y,steel}$$

MINIMAL COMPLIANCE: OPTIMAL MATERIAL DISTRIBUTION

Thickness of the vertical layers



Thickness of the horizontal layers



MATERIAL DESIGN FOR OPTIMAL MACROSCOPIC THERMAL RESPONSE USING FREE MATERIAL OPTIMIZATION (FMO)

with S. Giusti (GIDMA)

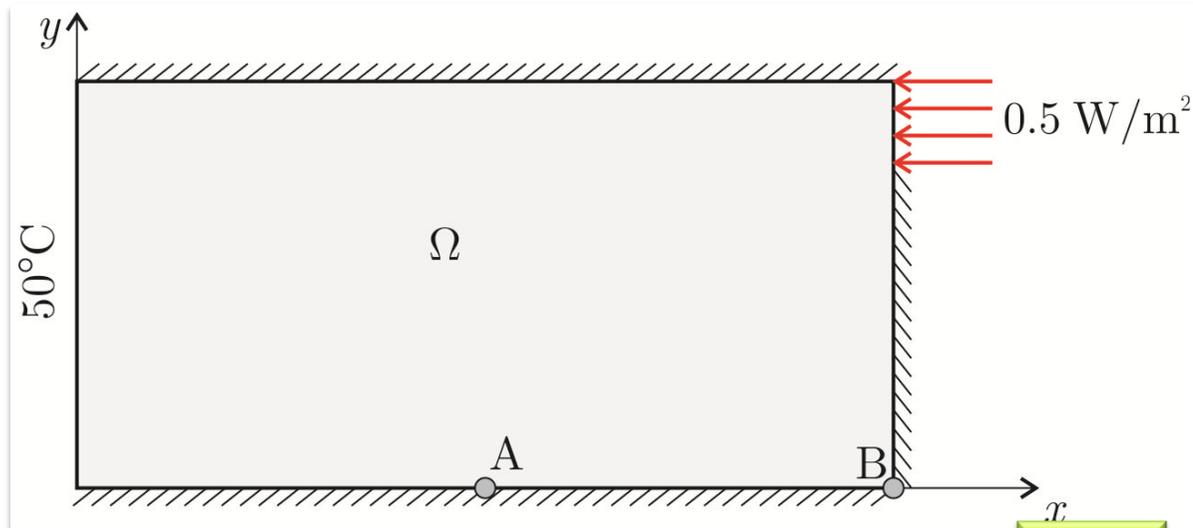
FREE MATERIAL OPTIMIZATION OF THE THERMAL RESPONSE

- **FREE MATERIAL OPTIMIZATION (FMO):** the design variables are the effective properties themselves
- For $\mathbf{P} = [k_{xx}^{(1)}, k_{yy}^{(1)}, k_{xx}^{(2)}, k_{yy}^{(2)}, \dots]$ (with $k_{xx}^{(n)}, k_{yy}^{(n)}$, and $k_{xy}^{(n)} = 0$ being the effective conductivities at node n), let us find

$$\mathbf{P}^{\text{opt}} = \arg \min_{\mathbf{P}} \sum_{i \in \overline{AB}} (T_i(\mathbf{P}) - 200^\circ\text{C})^2$$

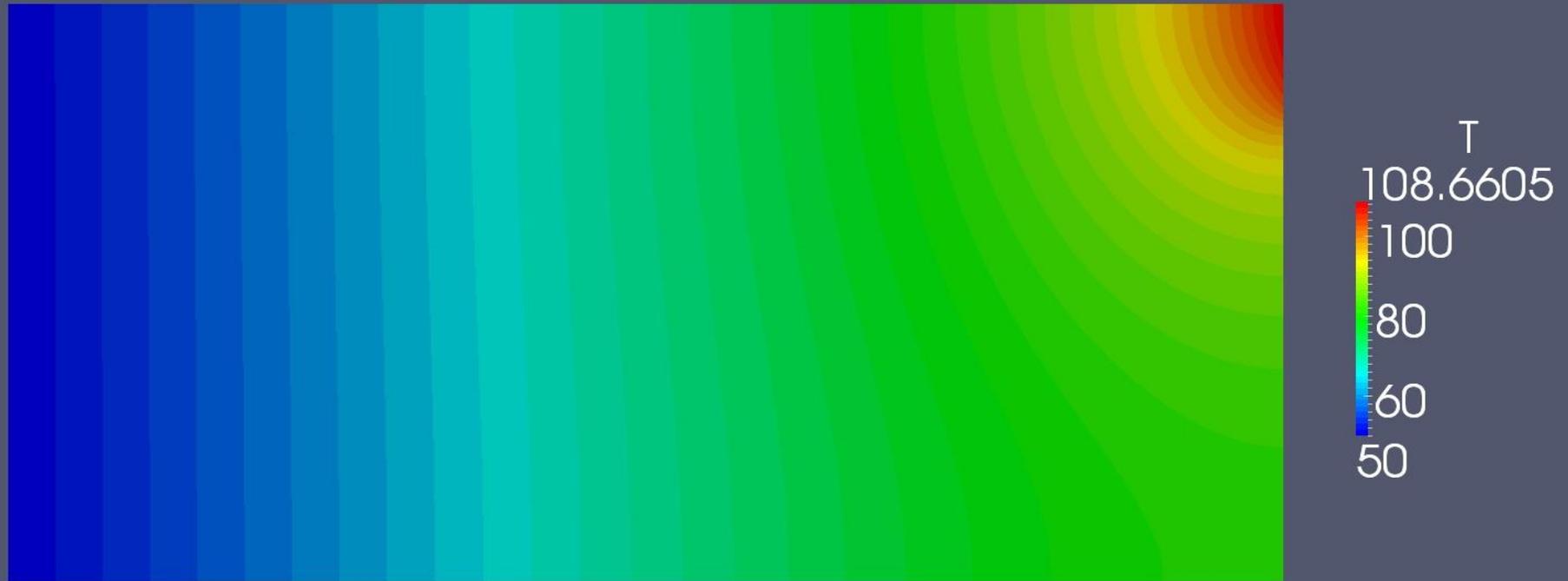
subject to

$$0.001 \leq k_{xx}^{(n)}, k_{yy}^{(n)} \leq 1$$

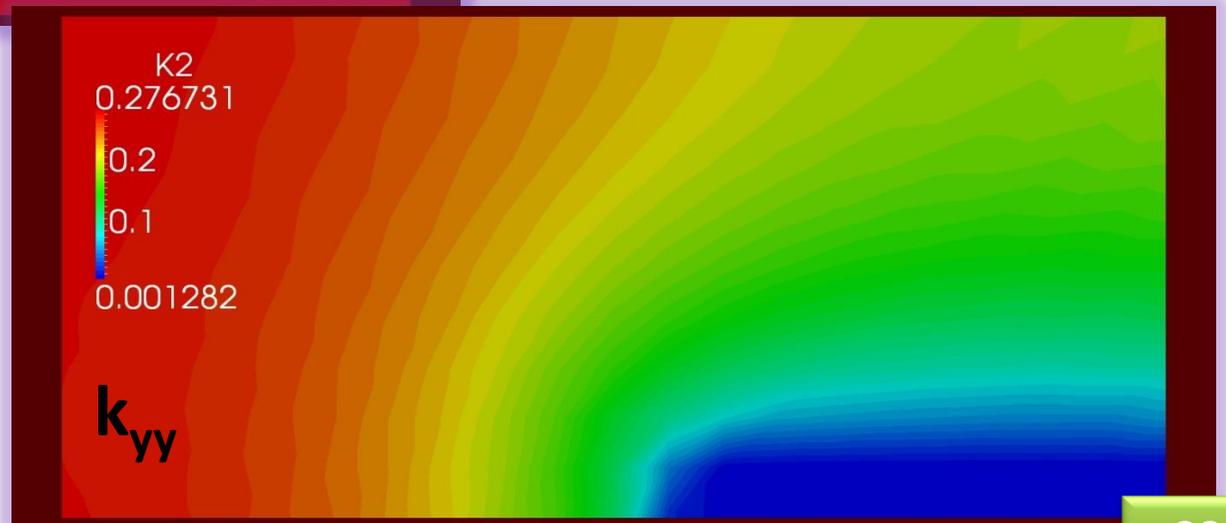
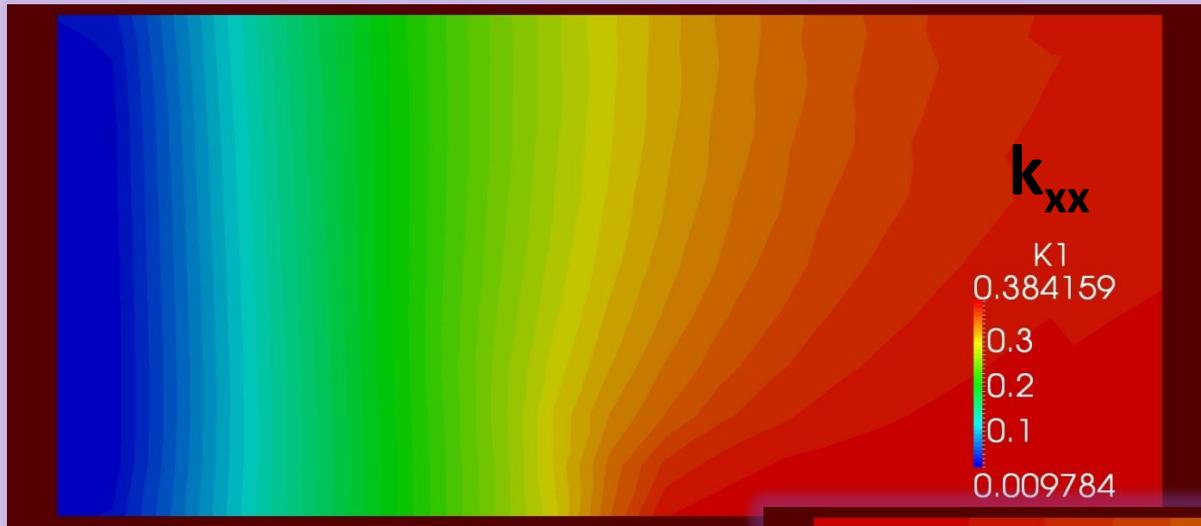


INITIAL TEMPERATURE DISTRIBUTION

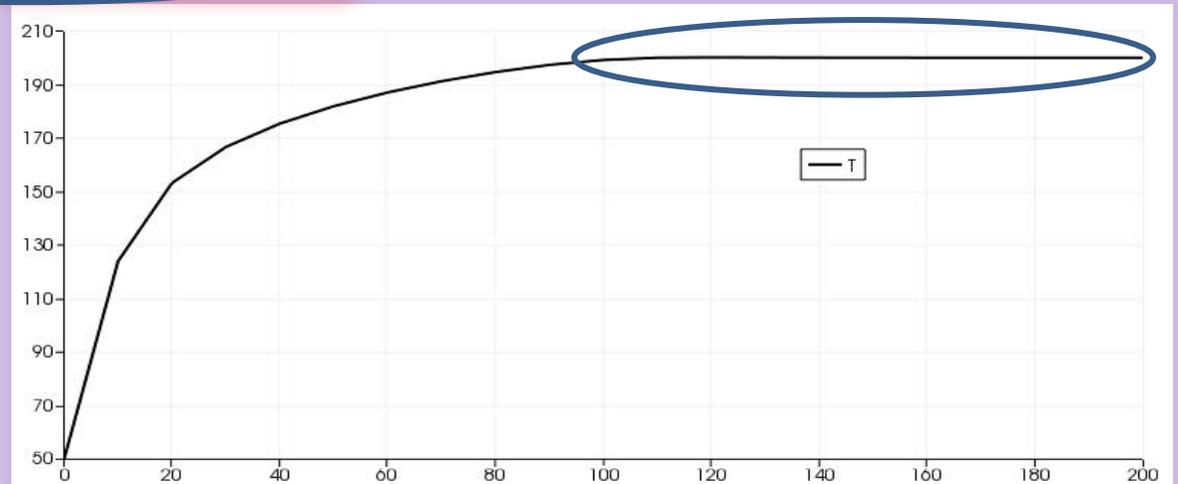
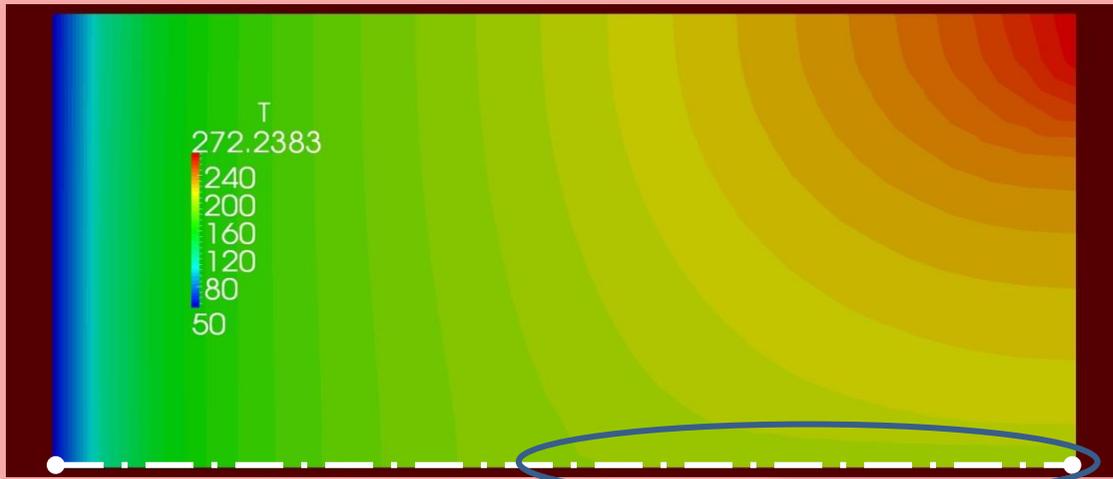
Initial guess: $k_{xx} = k_{yy} = 0.5$



OPTIMAL DISTRIBUTIONS OF CONDUCTIVITIES



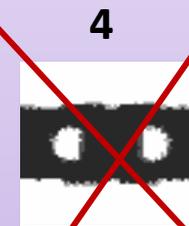
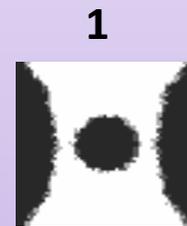
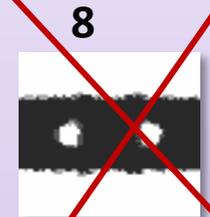
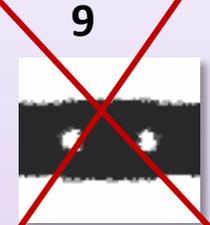
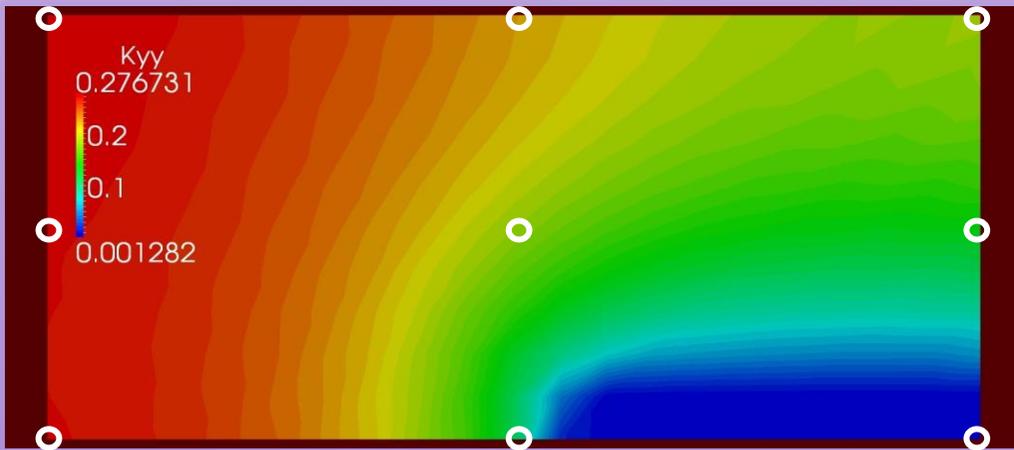
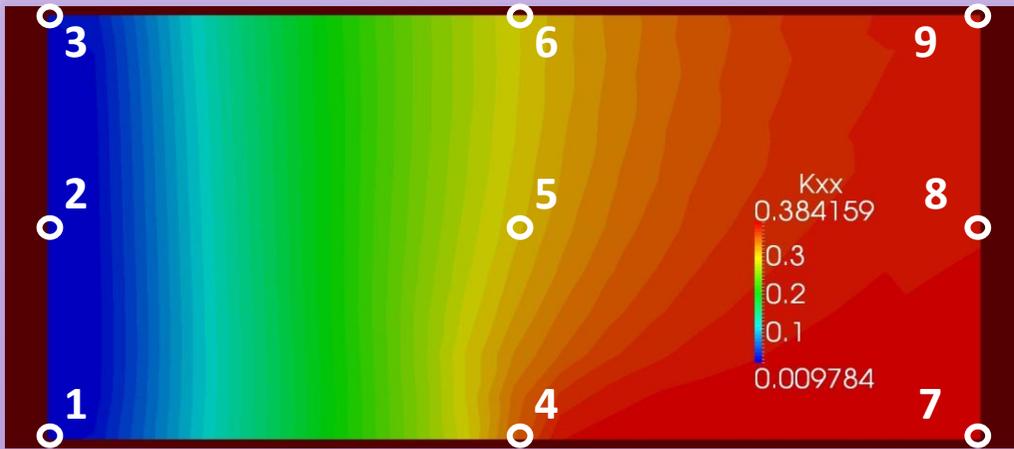
TEMPERATURE FOR THE OPTIMAL SOLUTION



DETERMINATION OF THE MICROSTRUCTURE

- Knowing the optimal macroscopic k_{xx} and k_{yy} at a point of the mesh, a **topology optimization** problem is solved to determine the microstructure we need to achieve such k_{xx} and k_{yy}
- Topology optimization using the **topology derivative** approach

TOPOLOGY OPTIMIZATION AT THE MICROSCALE

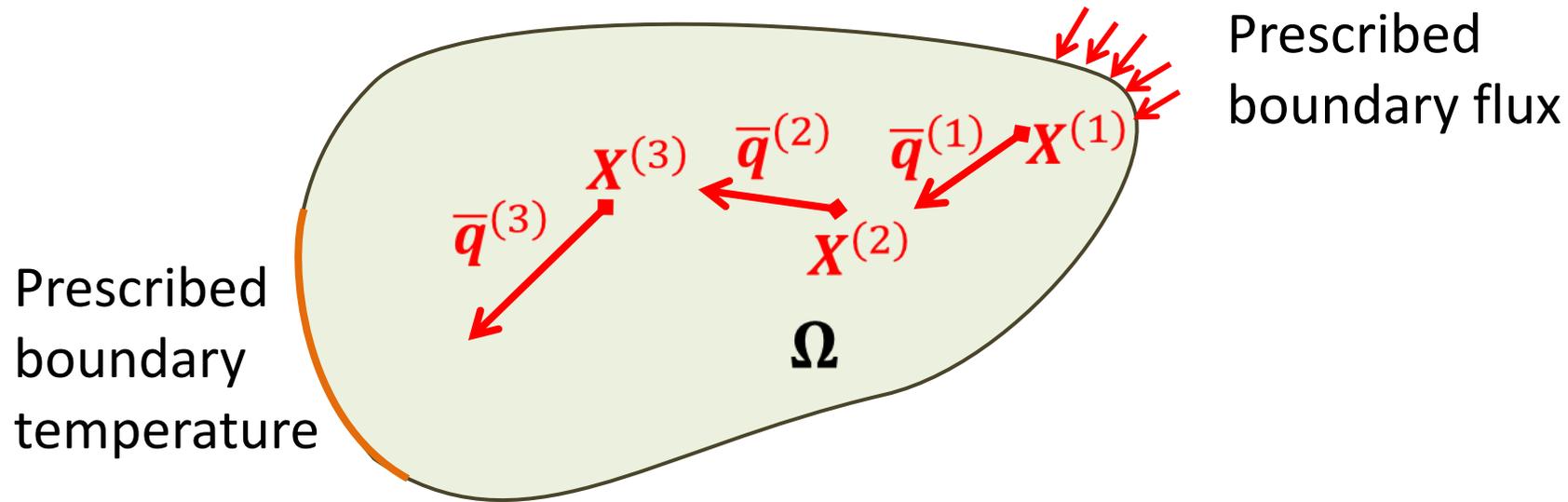


COMPUTATIONAL METAMATERIAL DESIGN FOR HEAT FLUX MANIPULATION

with

I. Peralta, A. Ciarbonetti (CIMEC)

MANIPULATING THE HEAT FLUX



- Given $\bar{q}^{(q)}$ as the desired heat flux at $X^{(q)}$, $q = 1, 2, \dots, N_q$, you have to find \mathbf{P} such that

$$[-\mathbf{k}(\mathbf{p})\text{grad } T(\mathbf{P})]_{X^{(q)}} = \bar{q}^{(q)} \quad \text{for } i = 1, 2, \dots, N_q$$

HEAT FLUX MANIPULATION AS AN OPTIMIZATION PROBLEM

- In order to perform the given task as well as possible, let us solve the nonlinear optimization problem

$$\min_{\text{feasible } \mathbf{P}} \underbrace{\frac{1}{N_q} \sum_{q=1}^{N_q} \left\| [-\mathbf{k}(\mathbf{p}) \text{grad } T(\mathbf{P})]_{\mathbf{X}^{(q)}} - \bar{\mathbf{q}}^{(q)} \right\|^2}_{\text{MSE}(\mathbf{P})}$$

subject to constraints accounting for, *at least*, the feasibility of the microstructure.

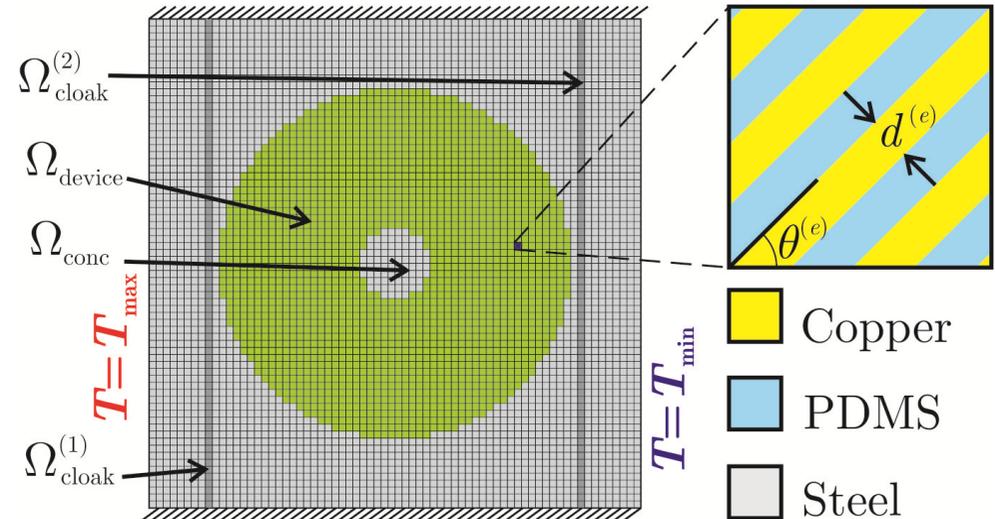
- ☹ Maybe, $\text{MSE}(\mathbf{P}) \neq 0$ for all feasible \mathbf{P}
- ☺ We'll find the “optimal” feasible \mathbf{P}

DESIGN OF A HEAT FLUX CONCENTRATION AND CLOAKING DEVICE

- To find $\mathbf{P}^{\text{opt}} = [d^{(1)}, \theta^{(1)}, \dots, d^{(N)}, \theta^{(N)}]^{\text{opt}}$ ($N = 1896$ is the # elems in Ω_{device}) such that

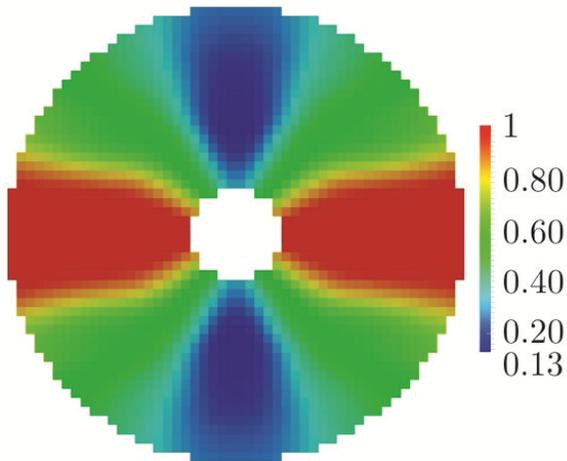
$$\mathbf{P}^{\text{opt}} = \arg \min_{\mathbf{P}} \frac{1}{N_q} \sum_q \left\| [-\mathbf{k}(\mathbf{p}) \text{grad } T(\mathbf{P})]_{\mathbf{X}^{(q)}} - \bar{\mathbf{q}}^{(q)} \right\|^2$$

subject to the box constraints

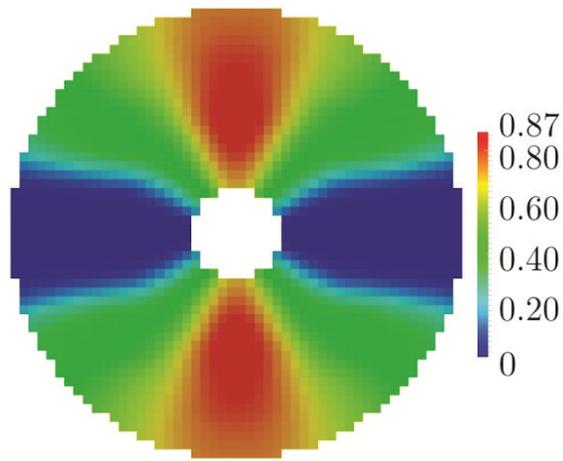


HEAT FLUX CONCENTRATION AND CLOAKING: OPTIMAL METAMATERIAL DISTRIBUTION

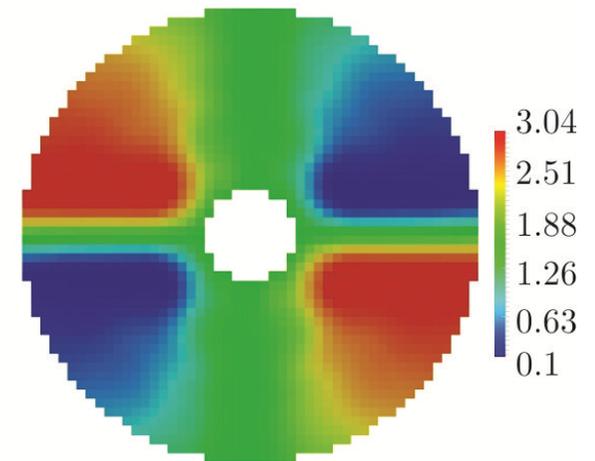
Fraction of copper



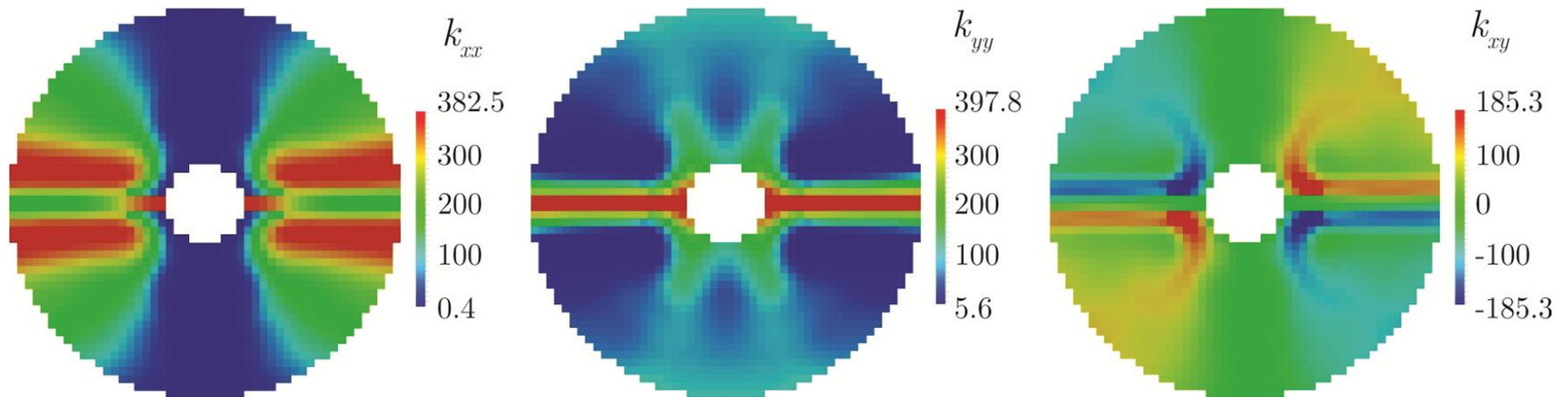
Fraction of PDMS



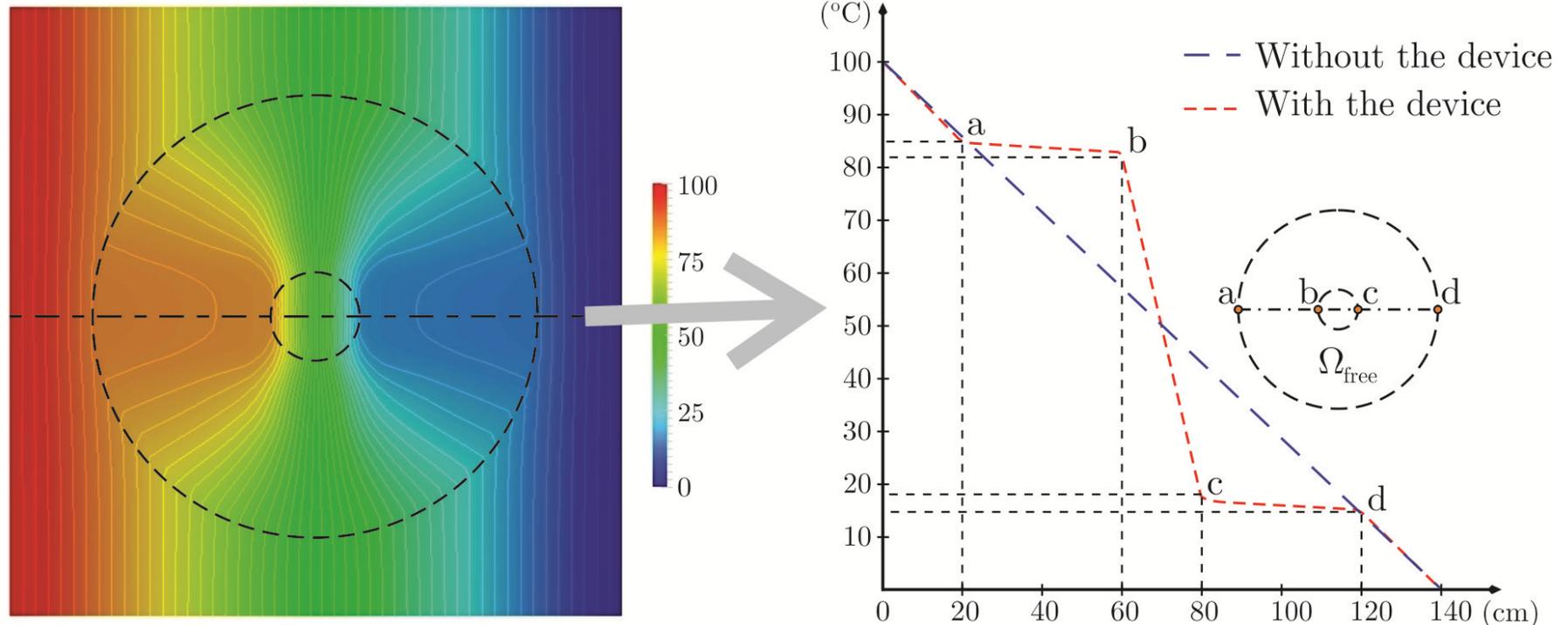
Orientation



HEAT FLUX CONCENTRATION AND CLOAKING: OPTIMAL CONDUCTIVITY DISTRIBUTION



HEAT FLUX CONCENTRATION AND CLOAKING: OPTIMAL TEMPERATURE DISTRIBUTION



* Peralta, Fachinotti & Ciaronetti, Scientific Reports 2017
(<http://www.nature.com/articles/srep40591>)

EASY-TO-MAKE HEAT FLUX MANIPULATING DEVICES USING DISCRETE MATERIAL OPTIMIZATION (DMO)

with

I. Peralta, A. Ciarbonetti (CIMEC)

MULTIPHASE TOPOLOGY OPTIMIZATION

- The material at the element $\Omega^{(e)}$ is either one of M predefined, candidate materials with conductivities $\mathbf{k}_1, \mathbf{k}_2, \dots, \mathbf{k}_M$
- Each material maybe a **metamaterial** itself
- The design variables for $\Omega^{(e)}$ are the fractions $f_m^{(e)}$ of each material $m = 1, 2, \dots, M$
- The conductivity at $\Omega^{(e)}$ is defined by the mixture law
$$\mathbf{k}^{(e)} = f_1^{(e)} \mathbf{k}_1 + f_2^{(e)} \mathbf{k}_2 + \dots + f_M^{(e)} \mathbf{k}_M$$
- We must use an optimization algorithm driving to optimal solutions with $f_m^{(e)} \approx 1$ or $f_m^{(e)} \approx 0$

DISCRETE MATERIAL OPTIMIZATION

- Using the **Discrete Material Optimization (DMO)** approach proposed by Stegmann & Lund (IJNME 2005), we define:

$$f_m^{(e)} = \frac{f_m^*(\mathbf{p}^{(e)})}{\sum_i f_i^*(\mathbf{p}^{(e)})} = f_m(\mathbf{p}^{(e)})$$

$$\text{with } f_m^*(\mathbf{p}^{(e)}) = \left(\rho_i^{(e)}\right)^p \prod_{j=1, j \neq i}^M \left[1 - \left(\rho_i^{(e)}\right)^p\right]$$

- The design variables for $\Omega^{(e)}$ are $\mathbf{p}^{(e)} = [\rho_1^{(e)}, \rho_2^{(e)}, \dots, \rho_M^{(e)}]$
 $\rho_i^{(e)}$: artificial density of material m at $\Omega^{(e)}$, like in Topology Optimization
- $p \geq 3$, like in SIMP for Topology Optimization
- This definition strongly forces $\rho_{j \neq i}^{(e)} \rightarrow 0$ when $\rho_i^{(e)} \rightarrow 1$
- It doesn't need a constraint (one per finite element) to make $\sum f^{(e)} = 1$

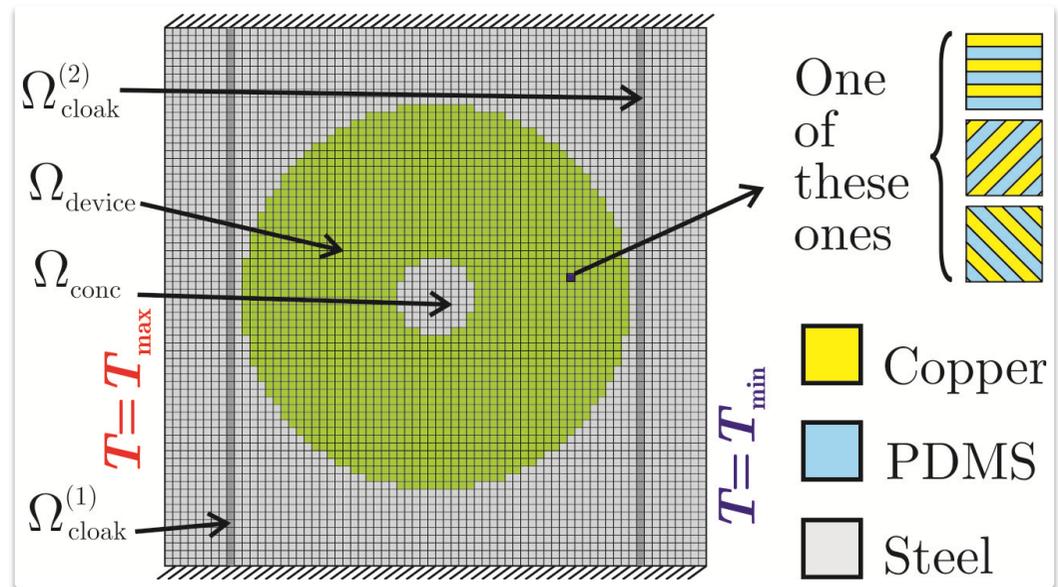
DESIGN OF A HEAT FLUX CONCENTRATION AND CLOAKING DEVICE USING DMO

- To find $\mathbf{P}^{\text{opt}} = [\rho_1^{(1)}, \rho_2^{(1)}, \rho_3^{(1)}, \dots, \rho_1^{(1896)}, \rho_2^{(1896)}, \rho_3^{(1896)}]^{\text{opt}}$ such that

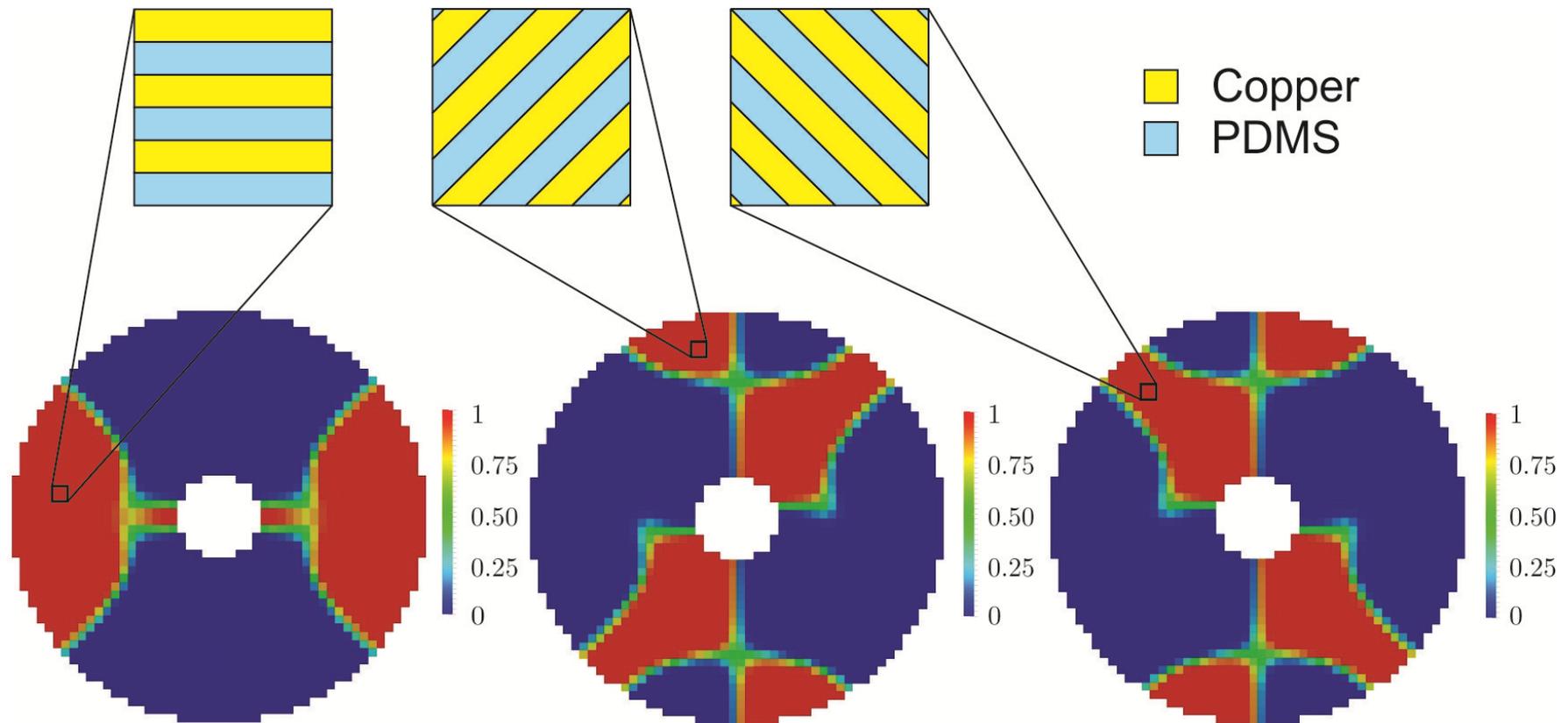
$$\mathbf{P}^{\text{opt}} = \arg \min_{\mathbf{P}} \frac{1}{N_q} \sum_q \left\| [-\mathbf{k}(\mathbf{p}) \text{grad } T(\mathbf{P})]_{\mathbf{X}^{(q)}} - \bar{\mathbf{q}}^{(q)} \right\|^2$$

subject to the box constraints

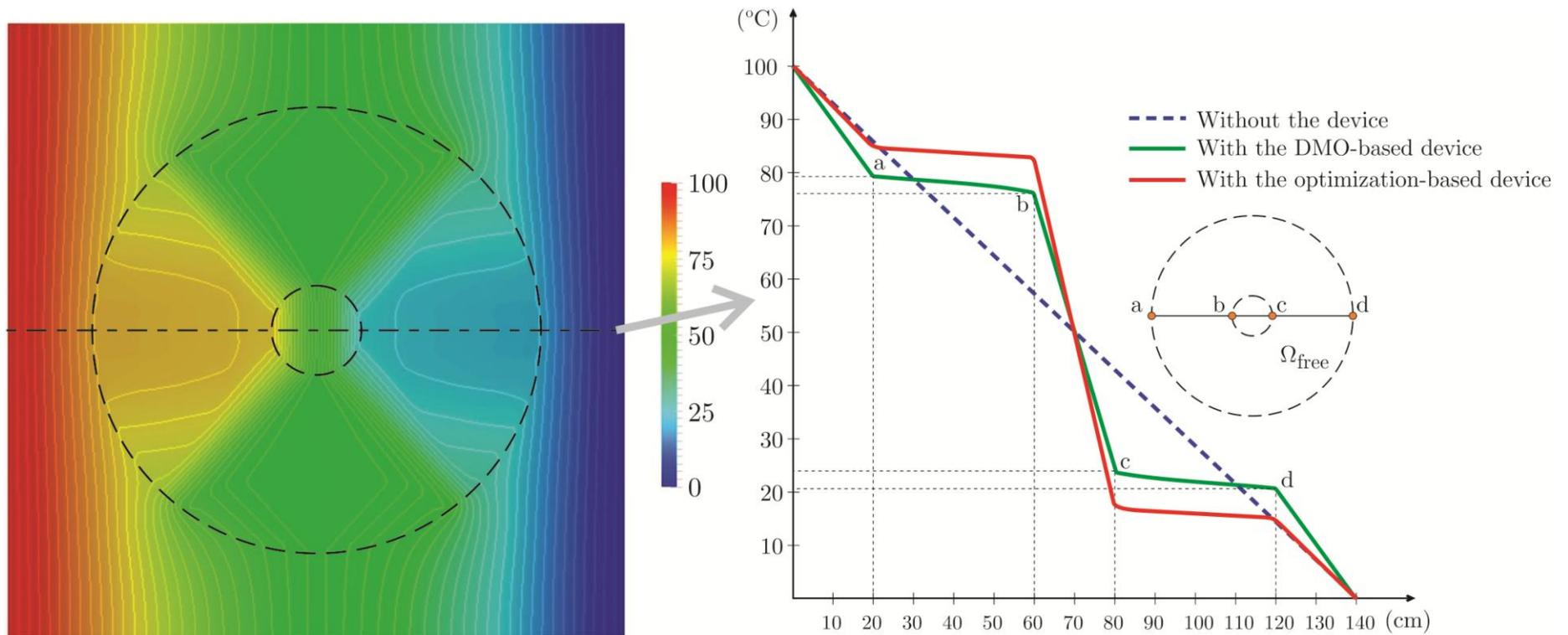
$0 < \rho < 1$



HEAT FLUX CONCENTRATION AND CLOAKING USING DMO: OPTIMAL METAMATERIAL DISTRIBUTION



HEAT FLUX CONCENTRATION AND CLOAKING USING DMO: OPTIMAL TEMPERATURE DISTRIBUTION



EASIEST-TO-MAKE HEAT FLUX MANIPULATING DEVICES USING TOPOLOGY OPTIMIZATION

with

**A. Ciarbonetti, I. Peralta (CIMEC),
I. Rintoul (INTEC)**

TOPOLOGY OPTIMIZATION

- The material at the element $\Omega^{(e)}$ is either one of two predefined, candidate materials with conductivities $\mathbf{k}_1, \mathbf{k}_2$
- Each material is isotropic
- There is only one design variable for $\Omega^{(e)}$: the artificial density $\rho^{(e)}$ of material 1
- The conductivity at $\Omega^{(e)}$ is defined using **SIMP (Solid Isotropic Material with Penalization)**

$$\mathbf{k}^{(e)} = (\rho^{(e)})^p \mathbf{k}_1 + [1 - (\rho^{(e)})^p] \mathbf{k}_2$$

- *A priori*, using $p \geq 3$, $\rho^{(e)} \rightarrow 0$ or $\rho^{(e)} \rightarrow 1$ for the optimal solution

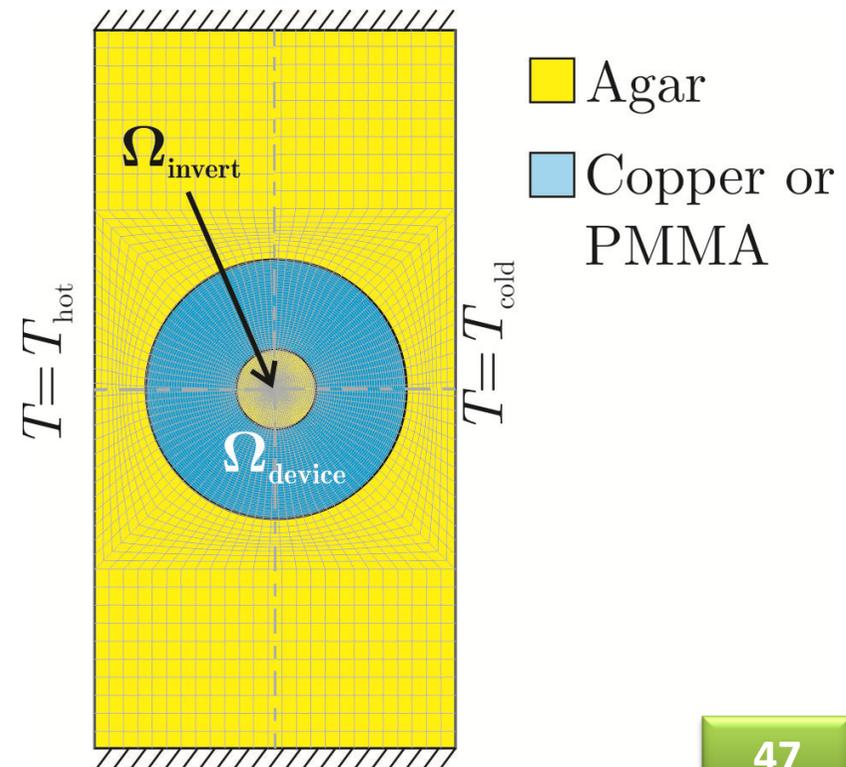
DESIGN OF HEAT FLUX INVERTER USING TOPOLOGICAL OPTIMIZATION

- To find $\mathbf{P}^{\text{opt}} = [\rho^{(1)}, \dots, \rho^{(4000)}]^{\text{opt}}$ such that

$$\mathbf{P}^{\text{opt}} = \arg \min_{\mathbf{P}} \frac{1}{N_q} \sum_q \left\| [-\mathbf{k}(\mathbf{p}) \text{grad } T(\mathbf{P})]_{\mathbf{x}^{(q)}} - \bar{\mathbf{q}}^{(q)} \right\|^2$$

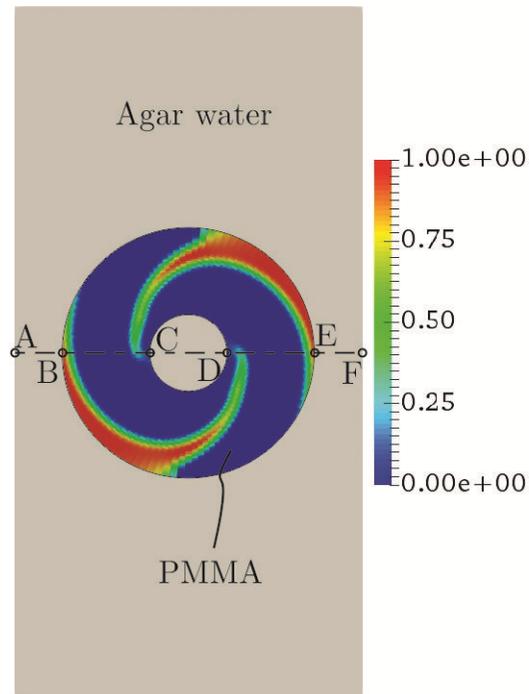
subject to the box constraints

$$0 < \rho(e) < 1$$

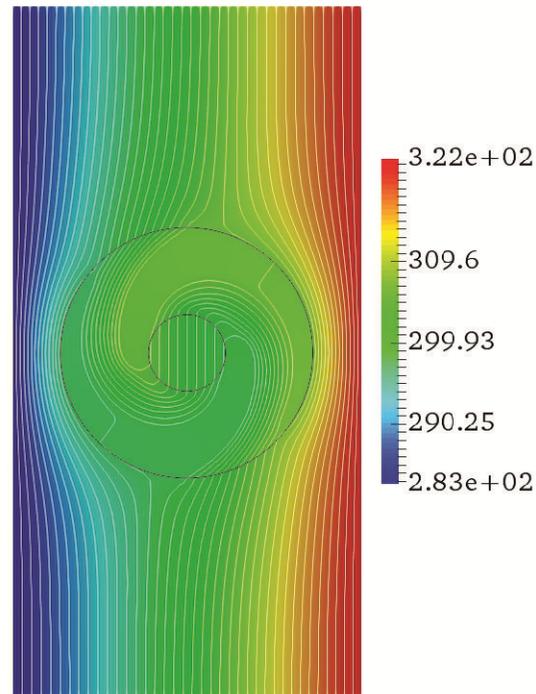


HEAT FLUX INVERTER: TOPOLOGY OPTIMIZATION SOLUTION

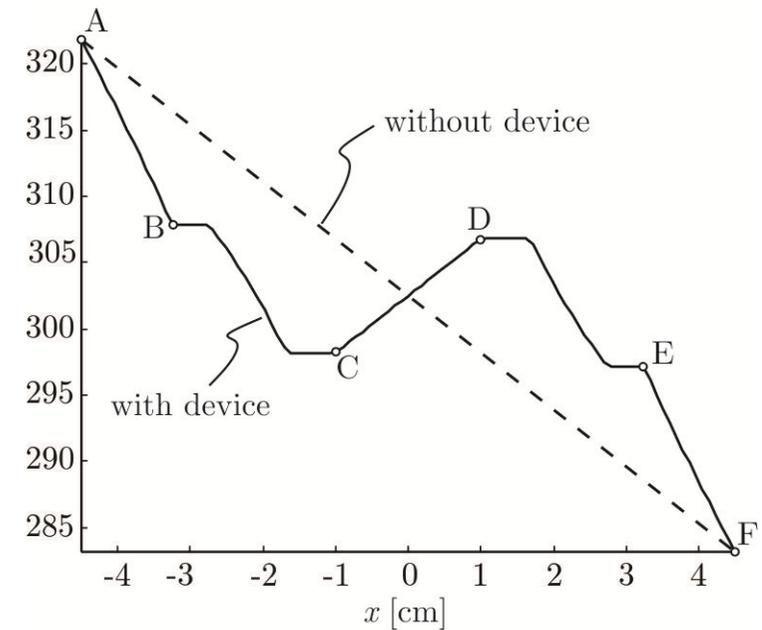
a) Copper fraction



b) Temperature [K] in the plate

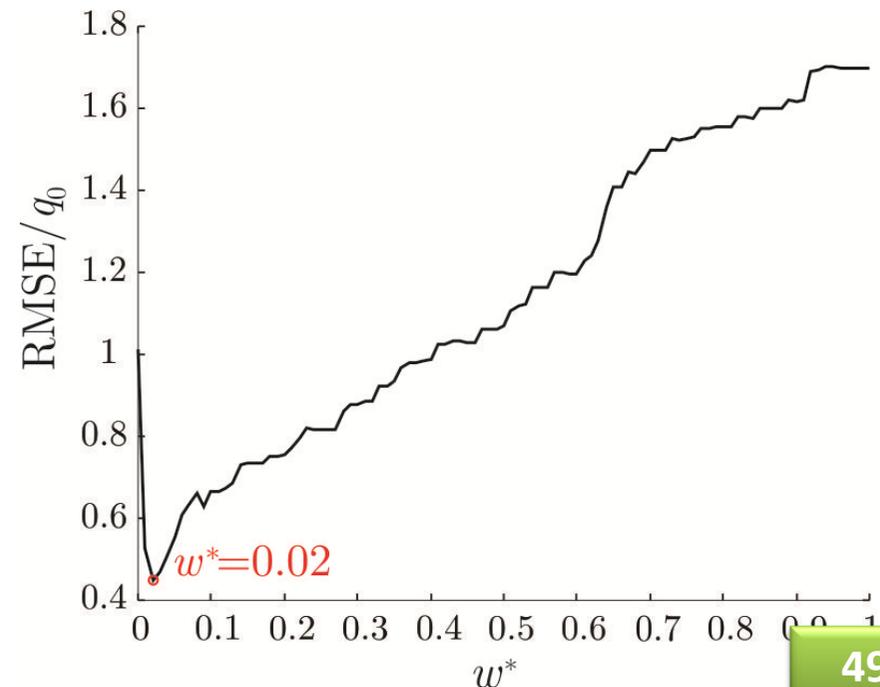


c) Temperature [K] along \overline{AF}



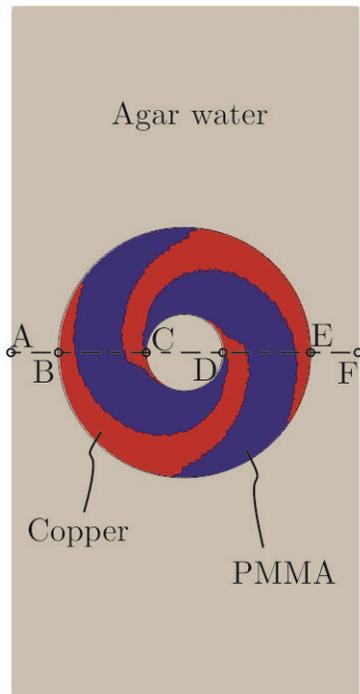
HEAT FLUX INVERTER: BLACK AND WHITE FILTERING

- For manufacturability, regions with intermediate material fractions (“grey zones”) must be avoided
- Black and white filters (Sigmund 2007) serve to this end
- Here, a simple *a posteriori* b&w filter is preferred: material fraction greater than w^* is taken to 1; otherwise, it is taken to 0

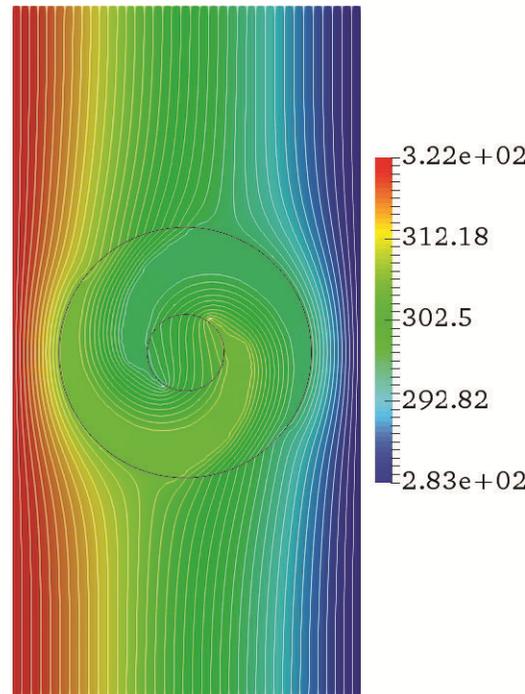


HEAT FLUX INVERTER: TOPOLOGY OPTIMIZATION SOLUTION + BLACK AND WHITE FILTERING

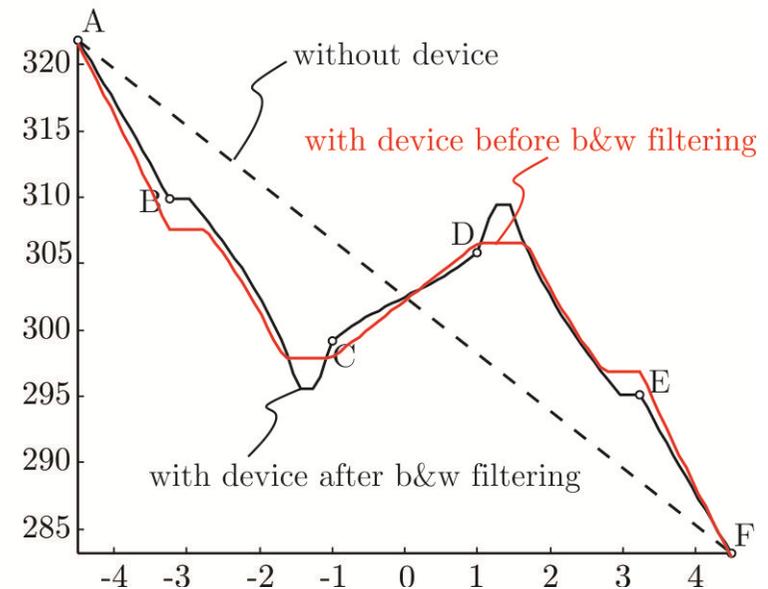
a) Materials



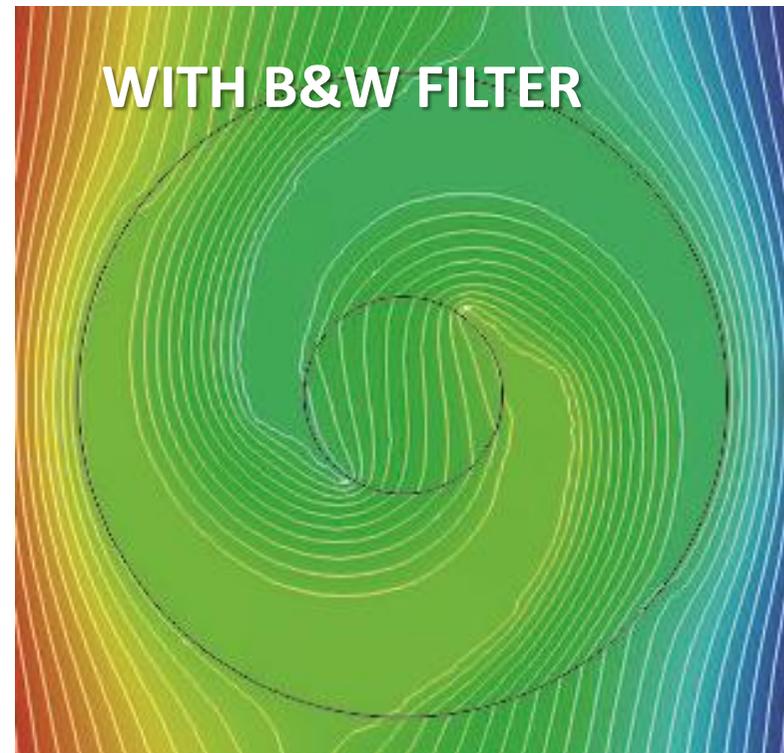
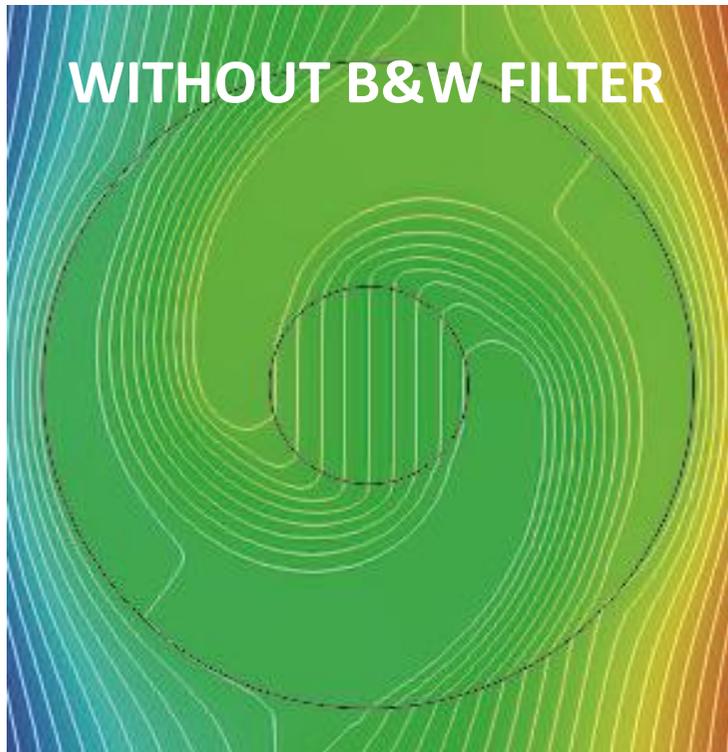
b) Temperature [K] in the plate



c) Temperature [K] along \overline{AF}

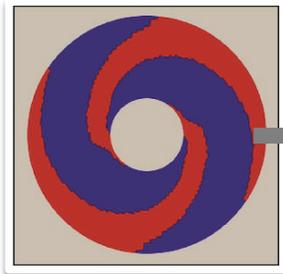


HEAT FLUX INVERTER: TOPOLOGY OPTIMIZATION WITH AND WITHOUT BLACK AND WHITE FILTERING



HEAT FLUX INVERTER: EXPERIMENTAL VALIDATION

Computationally
designed device



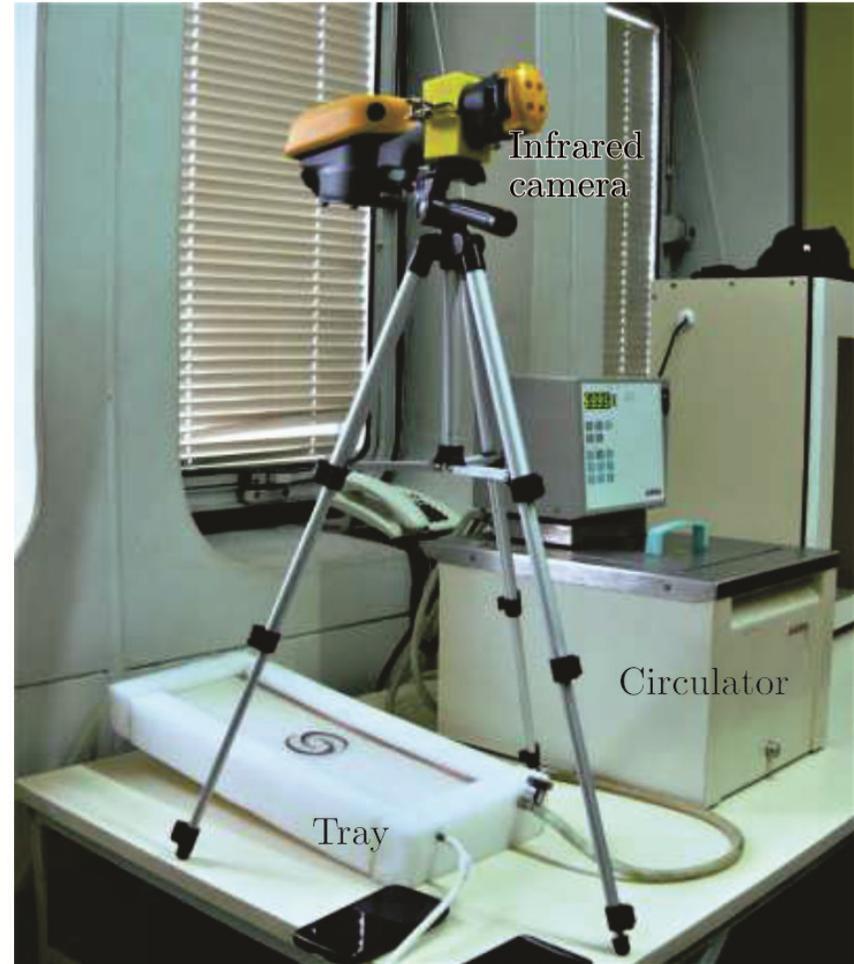
a) Fabricated device



b) Tested domain

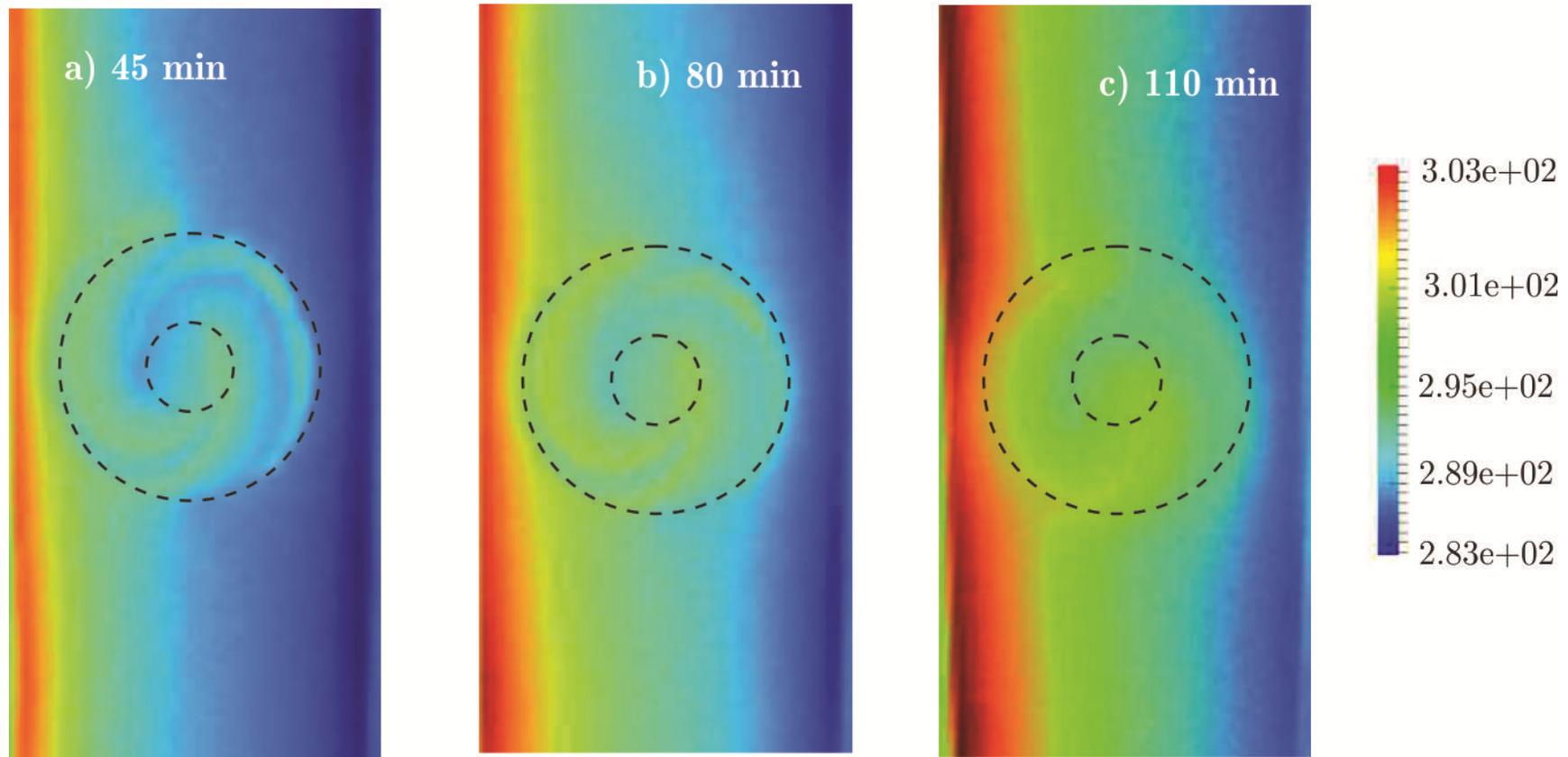


c) Experimental setup

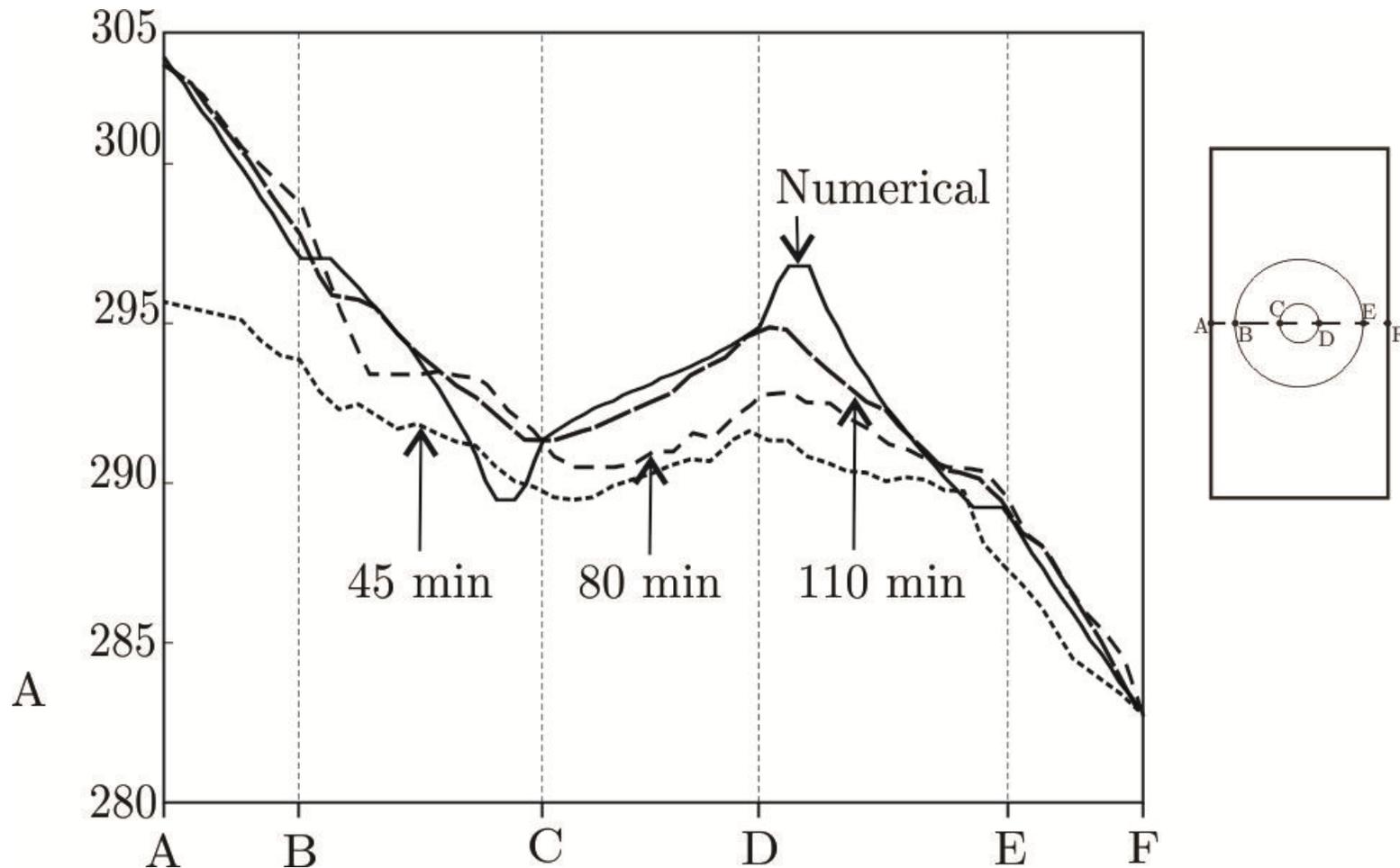


HEAT FLUX INVERTER: EXPERIMENTAL VALIDATION

Temperature evolution during the experiment [K]



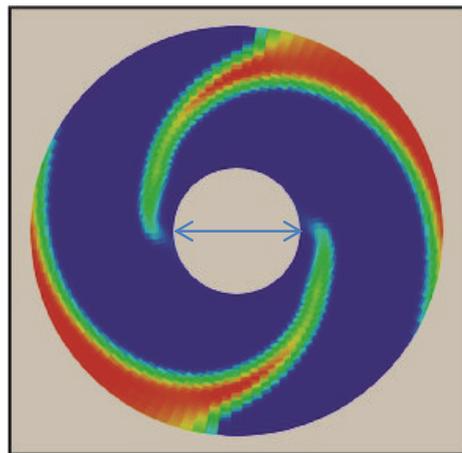
HEAT FLUX INVERTER: EXPERIMENTAL VALIDATION



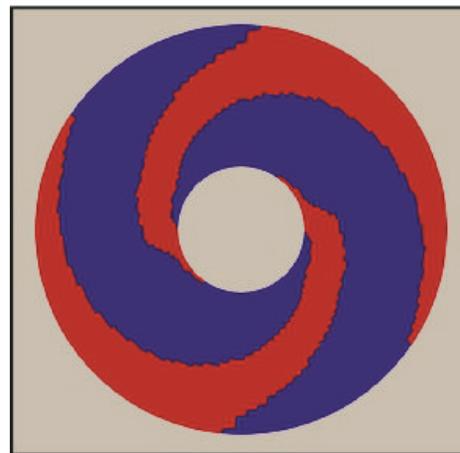
HEAT FLUX INVERTER: COMPARISON WITH NARAYANA AND SATO'S INVERTER

- Accomplishment of the inversion task

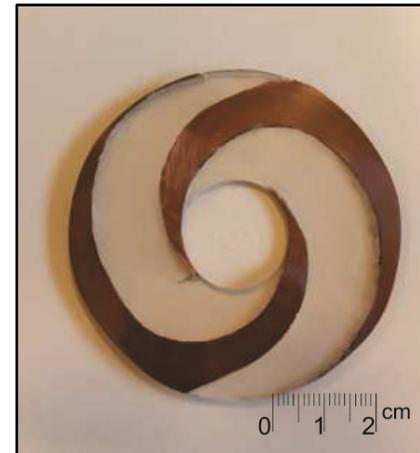
$$q_{\text{invert}} = -k_{\text{agar}} \frac{T_D - T_C}{|CD|} = -\alpha q_0$$



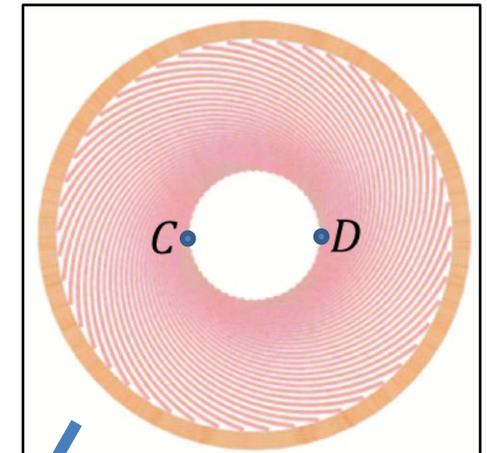
$$\alpha = 0.997$$



$$\alpha = 0.778$$



$$\alpha = 0.774$$



$$\alpha = 0.395$$

S. Narayana & Y. Sato, "Heat Flux Manipulation with Engineered Thermal Materials", Physical Review Letters 2012

HEAT FLUX INVERTER: COMPARISON WITH NARAYANA AND SATO'S INVERTER

- Narayana and Sato's device, designed using the **transformation-based** approach inherited from electromagnetism, has 96 PMMA-copper laminate arms to invert the flux coming from every where
 - The current device, designed using the **optimization-based** approach, has 2 copper arms to invert the given heat flux
- Narayana and Sato's device also performs cloaking as a collateral effect of its transformation-based design
 - The current device doesn't perform cloaking (it was not required)
⇒ better accomplishment of the inversion task

ADVANTAGES OF THE OPTIMIZATION-BASED DESIGN

- The optimization-based design (OBD) gives you the material distribution (inducing an adequate conductivity distribution) to accomplish a given task
 - The transformation-based design (TBD) gives you a required anisotropic conductivity field, and then you have to manage to achieve it
- OBD can be applied to arbitrary tasks, geometries and boundary conditions
 - TBD has not been (can't be?) applied to arbitrary tasks, geometries and boundary conditions
- OBD gives you the optimal device to accomplish the given task
 - TBD gives you the device to accomplish the given task + cloaking
 - ⇒ overdimensioning
 - ⇒ poorer accomplishment of the given task

PERSPECTIVES

- Robustness
 - instabilities
 - grey zones
 - convergence
- 3D
- Applications
 - Isolation: to deviate the heat flux from the zones where it is undesired, to drive it to somewhere where it maybe useful
 - Optimization of Austempered Ductile Iron (with B. Tourn)
 - Mechanical properties depend on the thermal history
 - Topology and heat treatment optimization to make a macroscopic piece have a given mechanical response
 - Metamaterials for wind turbine blades (with A. Albanesi)
- Fabrication, patents

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 - Research project PIP 2012-2014 GI-1105: “Computational Simulation of Multiphysics Problems. Application to Metal Solidification and Micro-Electro-Mechanical Devices”
- You, for your attention